

# 具有内部基准电压的 DACx1408 8 通道 16/14/12 位高电压输出 DAC

## 1 特性

- 性能
  - 在 16 位分辨率下具有单调性
  - INL: 16 位分辨率下为  $\pm 1$  LSB (最大值)
  - TUE: FSR 最大值  $\pm 0.1\%$
- 集成 2.5V 精密内部基准
  - 初始精度:  $\pm 2.5\text{mV}$  (最大值)
  - 低温漂:  $5\text{ppm}/^\circ\text{C}$  (典型值)
- 灵活的输出配置
  - 输出范围:  $\pm 2.5\text{V}$ 、 $\pm 5\text{V}$ 、 $\pm 10\text{V}$ 、 $\pm 20\text{V}$   
0 至 5V、0 至 10V、0 至 20V、0 至 40V
  - 差分输出模式
- 高驱动能力:  $\pm 25\text{mA}$  (相对于电源轨的摆幅为 1.5V)
- 三个专用 A-B 切换引脚可用于生成抖动信号
- 模拟温度输出
  - 传感器增益为  $-4\text{mV}/^\circ\text{C}$
- 50MHz SPI 兼容型串行接口
  - 4 线制模式, 工作电压为 1.7V 至 5.5V
  - 菊链运行方式
  - CRC 误差校验
- 温度范围:  $-40^\circ\text{C}$  至  $+125^\circ\text{C}$
- 小型封装
  - 6mm  $\times$  6mm, 40 引脚 VQFN

## 2 应用

- 光纤网络: 马赫-曾德调制器偏置控制
- 工业自动化
- 测试和测量

## 3 说明

DAC81408、DAC71408 和 DAC61408 (DACx1408) 是具有引脚兼容性和 16/14/12 位分辨率的 8 通道缓冲高电压输出数模转换器 (DAC) 系列产品。DACx1408 包括一个低漂移 2.5V 内部电压基准, 因此在大多数应用中无需使用外部精密基准。这些器件具有单调性, 并能提供  $\pm 1$  LSB INL 的高线性度。

用户可自行选择输出配置, 包括满量程双极输出电压  $\pm 20\text{V}$ 、 $\pm 10\text{V}$ 、 $\pm 5\text{V}$  或  $\pm 2.5\text{V}$  和满量程非双极输出电压 40V、20V、10V 或 5V。而且可以对每个 DAC 通道的满量程输出电压进行单独编程控制。集成的 DAC 输出缓冲器可实现高达 25mA 的灌电流或拉电流, 从而减少了对额外的运算放大器的需求。每个通道对都可进行相应配置, 从而提供经过失调校准的差分输出。通过三个专用 A-B 切换引脚, 可以生成最多具有三种频率的抖动信号。

DACx1408 包含的上电复位电路可在加电时将 DAC 输出端连接至接地端。输出端会保持该状态, 直至器件寄存器得到适当的运行配置。

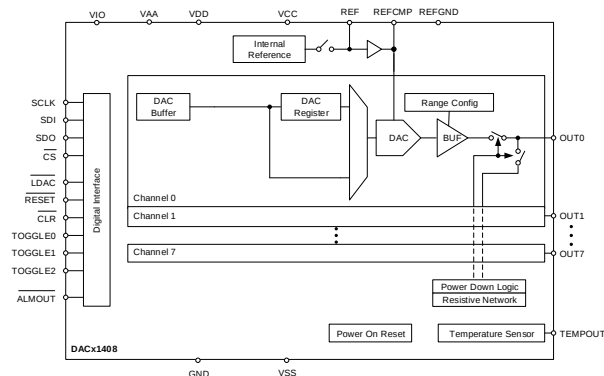
与 DACx1408 之间的通信通过一个支持 1.7V 至 5.5V 工作电压的 4 线制串行接口进行。

器件信息<sup>(1)</sup>

| 器件型号                             | 封装        | 封装尺寸 (标称值)             |
|----------------------------------|-----------|------------------------|
| DAC81408<br>DAC71408<br>DAC61408 | VQFN (40) | 6.00mm $\times$ 6.00mm |

(1) 如需了解所有可用封装, 请参阅数据表末尾的可订购产品附录。

功能方框图



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## 4 修订历史记录

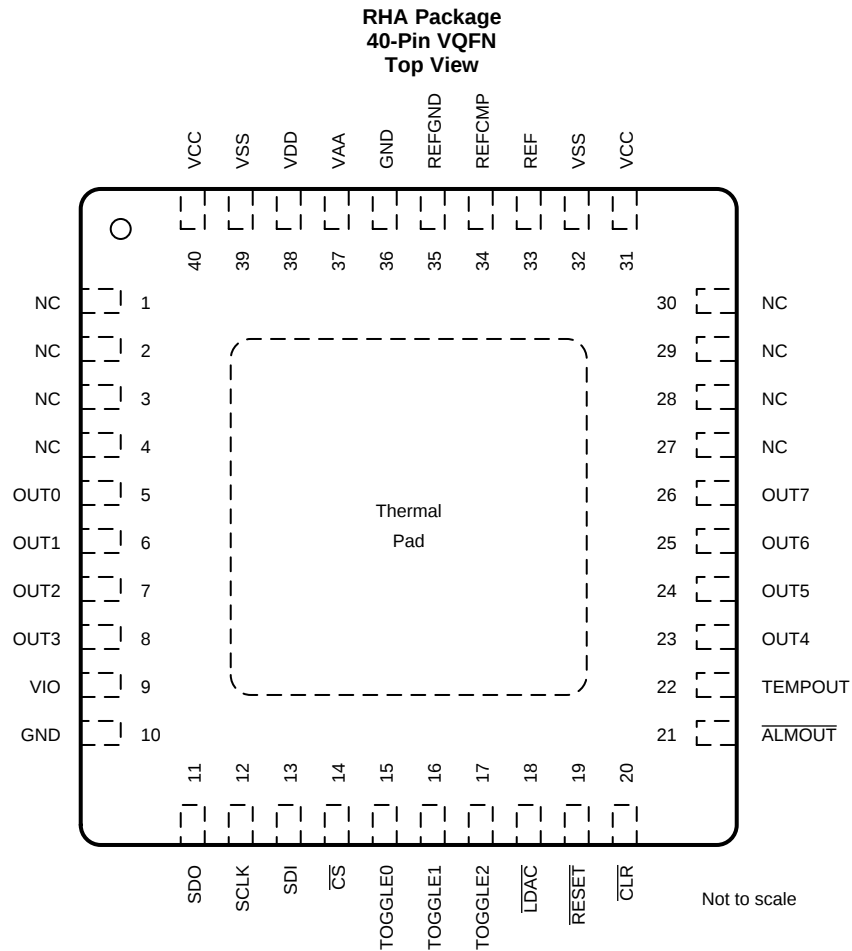
注：之前版本的页码可能与当前版本有所不同。

| Changes from Original (July 2018) to Revision A | Page |
|-------------------------------------------------|------|
| • 已更改 将 DAC81408 从“预告信息”更改为“生产数据”               | 1    |
| • 已更改 将 DAC71408 和 DAC61408 从“产品预览”更改为“生产数据”    | 1    |

## 5 Device Comparison Table

| DEVICE   | RESOLUTION |
|----------|------------|
| DAC81408 | 16-Bit     |
| DAC71408 | 14-Bit     |
| DAC61408 | 12-Bit     |

## 6 Pin Configuration and Functions



**DAC81408, DAC71408, DAC61408**

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**Pin Functions**

| PIN                        |                            | TYPE | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                           |
|----------------------------|----------------------------|------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME                       | NO.                        |      |                                                                                                                                                                                                                                                                                                                                                                       |
| OUT[0:7]                   | 5 - 8, 23 - 26             | O    | Analog DAC output voltages.                                                                                                                                                                                                                                                                                                                                           |
| NC                         | 1, 2, 3, 4, 27, 28, 29, 30 | O    | No connection.                                                                                                                                                                                                                                                                                                                                                        |
| VIO                        | 9                          | PWR  | IO supply voltage. (1.7 V to 5.5 V). This pin sets the I/O operating voltage for the device.                                                                                                                                                                                                                                                                          |
| GND                        | 10, 36                     | GND  | Ground reference point for all circuitry on the device.                                                                                                                                                                                                                                                                                                               |
| SDO                        | 11                         | O    | Serial interface data output. The SDO pin must be enabled before operation by setting the SDO-EN bit. Data are clocked out of the input shift register on either rising or falling edges of the SCLK pin as specified by the FSDO bit (rising edge by default).                                                                                                       |
| SCLK                       | 12                         | I    | Serial interface clock.                                                                                                                                                                                                                                                                                                                                               |
| SDI                        | 13                         | I    | Serial interface data input. Data are clocked into the input shift register on each falling edge of the SCLK pin.                                                                                                                                                                                                                                                     |
| $\overline{\text{CS}}$     | 14                         | I    | Active low serial data enable. This input is the frame synchronization signal for the serial data. When the signal goes low, it enables the serial interface input shift register.                                                                                                                                                                                    |
| TOGGLE0                    | 15                         | I    | Toggle pins. Control signals for those DAC outputs configured for toggle operation to switch between the two DAC data registers associated with each DAC. A logic low updates the DAC output to the value set by Register A. A logic high updates the DAC output to the value set by Register B. Connect the TOGGLE pins to ground if not using the toggle operation. |
| TOGGLE1                    | 16                         | I    |                                                                                                                                                                                                                                                                                                                                                                       |
| TOGGLE2                    | 17                         | I    |                                                                                                                                                                                                                                                                                                                                                                       |
| $\overline{\text{LDAC}}$   | 18                         | I    | Active low synchronization signal. When the $\overline{\text{LDAC}}$ pin is low, the DAC outputs of those channels configured in synchronous mode are updated simultaneously. Connect to VIO if unused.                                                                                                                                                               |
| $\overline{\text{RESET}}$  | 19                         | I    | Active low reset input. Logic low on this pin causes the device to issue a power-on-reset event.                                                                                                                                                                                                                                                                      |
| $\overline{\text{CLR}}$    | 20                         | I    | Active low clear input. Logic low on this pin clears all DAC outputs to their clear code. Connect to VIO if unused.                                                                                                                                                                                                                                                   |
| $\overline{\text{ALMOUT}}$ | 21                         | O    | $\overline{\text{ALMOUT}}$ is an open drain alarm output. An external 10-k $\Omega$ pull-up resistor to a voltage no higher than V <sub>IO</sub> is required.                                                                                                                                                                                                         |
| TEMPOUT                    | 22                         | O    | Analog temperature monitor output.                                                                                                                                                                                                                                                                                                                                    |
| VCC                        | 31, 40                     | PWR  | Output positive analog power supply (9 V to 41.5 V).                                                                                                                                                                                                                                                                                                                  |
| VSS                        | 32, 39                     | PWR  | Output negative analog power supply (-21.5 V to 0 V).                                                                                                                                                                                                                                                                                                                 |
| REF                        | 33                         | I/O  | Reference input to the device when operating with external reference. When using internal reference, this is the reference output voltage pin. Connect a 150-nF capacitor to ground.                                                                                                                                                                                  |
| REFCMP                     | 34                         | I/O  | Reference compensation capacitor connection. Connect a 330-pF capacitor between REFCMP and REFGND.                                                                                                                                                                                                                                                                    |
| REFGND                     | 35                         | GND  | Ground reference point for the internal reference.                                                                                                                                                                                                                                                                                                                    |
| VAA                        | 37                         | PWR  | Analog supply voltage (4.5 V to 5.5 V). This pin must be at the same potential as the VDD pin.                                                                                                                                                                                                                                                                        |
| VDD                        | 38                         | PWR  | Digital supply voltage (4.5 V to 5.5 V). This pin must be at the same potential as the VAA pin.                                                                                                                                                                                                                                                                       |
| THERMAL PAD                | –                          | –    | The thermal pad is located on the package underside. The thermal pad should be connected to any internal PCB ground plane through multiple vias for good thermal performance.                                                                                                                                                                                         |

## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                                                |                                    | MIN                   | MAX                   | UNIT |
|------------------------------------------------|------------------------------------|-----------------------|-----------------------|------|
| Supply voltage                                 | V <sub>DD</sub> to GND             | -0.3                  | 6                     | V    |
|                                                | V <sub>IO</sub> to GND             | -0.3                  | 6                     | V    |
|                                                | V <sub>CC</sub> to GND             | -0.3                  | 44                    | V    |
|                                                | V <sub>SS</sub> to GND             | -22                   | 0.3                   | V    |
|                                                | REFGND to GND                      | -0.3                  | 0.9                   | V    |
|                                                | V <sub>DD</sub> to V <sub>AA</sub> | -0.3                  | 0.3                   | V    |
|                                                | V <sub>CC</sub> to V <sub>SS</sub> | -0.3                  | 44                    | V    |
| Pin voltage                                    | DAC outputs to GND                 | V <sub>SS</sub> - 0.3 | V <sub>CC</sub> + 0.3 | V    |
|                                                | TEMPOUT to GND                     | -0.3                  | V <sub>DD</sub> + 0.3 | V    |
|                                                | REF and REFCMP to GND              | -0.3                  | V <sub>DD</sub> + 0.3 | V    |
|                                                | Digital inputs to GND              | -0.3                  | V <sub>IO</sub> + 0.3 | V    |
|                                                | SDO to GND                         | -0.3                  | V <sub>IO</sub> + 0.3 | V    |
|                                                | ALARMOUT to GND                    | -0.3                  | 6                     | V    |
| Operating junction temperature, T <sub>J</sub> |                                    | -40                   | 150                   | °C   |
| Storage temperature, T <sub>stg</sub>          |                                    | -60                   | 150                   | °C   |

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 7.2 ESD Ratings

|                    |                         |                                                                                | VALUE | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±1000 | V    |
|                    |                         | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                                    |                                                | MIN   | NOM | MAX             | UNIT |
|------------------------------------|------------------------------------------------|-------|-----|-----------------|------|
| V <sub>AA</sub> <sup>(1)</sup>     |                                                | 4.5   |     | 5.5             | V    |
| V <sub>DD</sub> <sup>(1)</sup>     |                                                | 4.5   |     | 5.5             | V    |
| V <sub>IO</sub>                    |                                                | 1.7   |     | 5.5             | V    |
| V <sub>CC</sub>                    |                                                | 9     |     | 41.5            | V    |
| V <sub>SS</sub> <sup>(2)</sup>     |                                                | -21.5 |     | 0               | V    |
| V <sub>CC</sub> - V <sub>SS</sub>  |                                                | 9     |     | 43              | V    |
| Digital input voltage              |                                                | 0     |     | V <sub>IO</sub> | V    |
| V <sub>REFIN</sub>                 | Reference input voltage to V <sub>REFGND</sub> | 2.49  | 2.5 | 2.51            | V    |
| V <sub>REFGND</sub> <sup>(3)</sup> | REFGND pin voltage                             | 0     | 0   | 0.6             | V    |
| T <sub>A</sub>                     | Operating ambient temperature                  | -40   |     | 125             | °C   |

- (1) V<sub>AA</sub> and V<sub>DD</sub> must be at the same potential.  
(2) V<sub>SS</sub> is only connected to GND when all DAC outputs are unipolar.  
(3) If V<sub>REFGND</sub> is not connected to GND, a buffered source must be used to drive it.

## 7.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | DACx1408   |
|-------------------------------|----------------------------------------------|------------|
|                               |                                              | RHA (VQFN) |
|                               |                                              | 40 PINS    |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 26.8       |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 14.1       |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 3.4        |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 0.2        |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 3.4        |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | 0.7        |

- (1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

## 7.5 Electrical Characteristics

all minimum/maximum specifications at  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  and all typical specifications at  $T_A = 25^{\circ}\text{C}$ ,  $V_{CC} = 9\text{ V}$  to  $41.5\text{ V}$ ,  $V_{SS} = -21.5\text{ V}$  to  $0\text{ V}$ ,  $V_{DD} = V_{AA} = 4.5\text{ V}$  to  $5.5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ ,  $V_{IO} = 1.7\text{ V}$  to  $5.5\text{ V}$ , DAC outputs unloaded, Digital inputs at  $V_{IO}$  or GND (unless otherwise noted)

| PARAMETER                                          |                                        | TEST CONDITIONS                                                                | MIN   | TYP         | MAX  | UNIT                           |
|----------------------------------------------------|----------------------------------------|--------------------------------------------------------------------------------|-------|-------------|------|--------------------------------|
| <b>STATIC PERFORMANCE<sup>(1)</sup></b>            |                                        |                                                                                |       |             |      |                                |
| DAC81408                                           | Resolution                             |                                                                                | 16    |             |      | Bits                           |
|                                                    | Integral nonlinearity (INL)            | All ranges, except 0 to 40 V and $\pm 2.5\text{ V}$                            | -1    | $\pm 0.5$   | 1    | LSB                            |
|                                                    |                                        | 0 to 40 V and $\pm 2.5\text{ V}$ range                                         | -2    | $\pm 1$     | 2    | LSB                            |
|                                                    | Differential nonlinearity (DNL)        | Specified 16-bit monotonic                                                     | -1    | $\pm 0.5$   | 1    | LSB                            |
| DAC71408                                           | Resolution                             |                                                                                | 14    |             |      | Bits                           |
|                                                    | Integral nonlinearity (INL)            | All ranges                                                                     | -1    | $\pm 0.5$   | 1    | LSB                            |
|                                                    | Differential nonlinearity (DNL)        | Specified 14-bit monotonic                                                     | -1    | $\pm 0.5$   | 1    | LSB                            |
| DAC61408                                           | Resolution                             |                                                                                | 12    |             |      | Bits                           |
|                                                    | Integral nonlinearity (INL)            | All ranges                                                                     | -1    | $\pm 0.5$   | 1    | LSB                            |
|                                                    | Differential nonlinearity (DNL)        | Specified 12-bit monotonic                                                     | -1    | $\pm 0.5$   | 1    | LSB                            |
| TUE                                                | Total unadjusted error                 | All ranges, except $\pm 2.5\text{ V}$                                          | -0.1  | $\pm 0.01$  | 0.1  | %FSR                           |
|                                                    |                                        | $\pm 2.5\text{ V}$ range                                                       | -0.2  | $\pm 0.02$  | 0.2  |                                |
|                                                    | Unipolar offset error                  | All unipolar ranges                                                            | -0.03 | $\pm 0.015$ | 0.03 | %FSR                           |
|                                                    | Unipolar zero-code error               | All unipolar ranges                                                            | 0     | 0.04        | 0.1  | %FSR                           |
|                                                    | Bipolar zero error                     | All bipolar ranges                                                             | -0.2  | $\pm 0.02$  | 0.2  | %FSR                           |
|                                                    | Full-scale error                       | All ranges                                                                     | -0.2  | $\pm 0.075$ | 0.2  | %FSR                           |
|                                                    | Gain error                             | All ranges, except $\pm 2.5\text{ V}$                                          | -0.1  | $\pm 0.02$  | 0.1  | %FSR                           |
|                                                    |                                        | $\pm 2.5\text{ V}$ range                                                       | -0.2  | $\pm 0.02$  | 0.2  |                                |
|                                                    | Unipolar offset error drift            | All unipolar ranges                                                            |       | $\pm 2$     |      | ppm of FSR/ $^{\circ}\text{C}$ |
|                                                    | Bipolar zero error drift               | All bipolar ranges                                                             |       | $\pm 2$     |      | ppm of FSR/ $^{\circ}\text{C}$ |
|                                                    | Gain error drift                       | All ranges                                                                     |       | $\pm 2$     |      | ppm of FSR/ $^{\circ}\text{C}$ |
|                                                    | Output voltage drift over time         | $T_A = 40^{\circ}\text{C}$ , Full-scale code, 1900 hours                       |       | 5           |      | ppm of FSR                     |
| <b>DIFFERENTIAL MODE PERFORMANCE<sup>(1)</sup></b> |                                        |                                                                                |       |             |      |                                |
| TUE                                                | Total unadjusted error                 | All ranges                                                                     | -0.1  | $\pm 0.01$  | 0.1  | %FSR                           |
|                                                    |                                        | $\pm 2.5\text{ V}$ range                                                       | -0.2  | $\pm 0.02$  | 0.2  |                                |
|                                                    | Common mode error                      | All bipolar ranges. Midscale code                                              | -0.1  | $\pm 0.01$  | 0.1  | %FSR                           |
| <b>OUTPUT CHARACTERISTICS</b>                      |                                        |                                                                                |       |             |      |                                |
|                                                    | Output voltage headroom                | to $V_{SS}$ and $V_{CC}$<br>( $-10\text{ mA} \leq I_{OUT} \leq 10\text{ mA}$ ) | 1     |             |      | V                              |
|                                                    |                                        | to $V_{SS}$ and $V_{CC}$<br>( $-15\text{ mA} \leq I_{OUT} \leq 15\text{ mA}$ ) | 1.5   |             |      |                                |
|                                                    | Short circuit current <sup>(2)</sup>   | Full-scale output shorted to $V_{SS}$                                          |       | 40          |      | mA                             |
|                                                    |                                        | Zero-scale output shorted to $V_{CC}$                                          |       | 40          |      |                                |
|                                                    | Load regulation                        | Midscale code, $-15\text{ mA} \leq I_{OUT} \leq 15\text{ mA}$                  |       | 70          |      | $\mu\text{V}/\text{mA}$        |
|                                                    | Maximum capacitive load <sup>(3)</sup> | $R_{LOAD} = \text{open}$                                                       | 0     |             | 1    | nF                             |
|                                                    | DC output impedance                    | Midscale code                                                                  |       | 0.05        |      | $\Omega$                       |
|                                                    |                                        | Full-scale code                                                                |       | 40          |      |                                |

(1) End point fit between codes. 16-bit: Code 256 to 65280, 14-bit: Code 128 to 16256, 12-bit: Code 32 to 4064.

(2) Temporary overload condition protection. Junction temperature can be exceeded during current limit. Operation above the specified maximum junction temperature may impair device reliability.

(3) Specified by design and characterization, not production tested.

**DAC81408, DAC71408, DAC61408**

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**Electrical Characteristics (continued)**

all minimum/maximum specifications at  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  and all typical specifications at  $T_A = 25^{\circ}\text{C}$ ,  $V_{CC} = 9\text{ V}$  to  $41.5\text{ V}$ ,  $V_{SS} = -21.5\text{ V}$  to  $0\text{ V}$ ,  $V_{DD} = V_{AA} = 4.5\text{ V}$  to  $5.5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ ,  $V_{IO} = 1.7\text{ V}$  to  $5.5\text{ V}$ , DAC outputs unloaded, Digital inputs at  $V_{IO}$  or GND (unless otherwise noted)

| PARAMETER                  |                                 | TEST CONDITIONS                                                                                                                                                                               | MIN | TYP  | MAX | UNIT                   |
|----------------------------|---------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|------------------------|
| <b>DYNAMIC PERFORMANCE</b> |                                 |                                                                                                                                                                                               |     |      |     |                        |
|                            | Output voltage settling time    | $\frac{1}{4}$ to $\frac{3}{4}$ scale and $\frac{3}{4}$ to $\frac{1}{4}$ scale settling time to $\pm 1\text{ LSB}$ , $\pm 10\text{ V}$ range, $R_L = 5\text{ k}\Omega$ , $C_L = 200\text{ pF}$ |     | 12   |     | $\mu\text{s}$          |
|                            | Slew rate                       | 0 to 5 V range                                                                                                                                                                                |     | 1    |     | $\text{V}/\mu\text{s}$ |
|                            |                                 | All other output ranges                                                                                                                                                                       |     | 4    |     |                        |
|                            | Power-on glitch magnitude       | Power-down to active DAC output. $\pm 20\text{ V}$ range, midscale code, $R_L = 5\text{ k}\Omega$ , $C_L = 200\text{ pF}$                                                                     |     | 0.3  |     | V                      |
|                            | Output noise                    | 0.1 Hz to 10 Hz, midscale code, 0 to 5 V range                                                                                                                                                |     | 15   |     | $\mu\text{Vpp}$        |
|                            | Output noise density            | 1 kHz, midscale code, 0 to 5 V range                                                                                                                                                          |     | 78   |     | $\text{nV}/\text{Hz}$  |
|                            | AC PSRR                         | Midscale code, frequency = 60 Hz, amplitude 200 mVpp superimposed on $V_{DD}$ , $V_{CC}$ or $V_{SS}$                                                                                          |     | 1    |     | LSB/V                  |
|                            | DC PSRR                         | Midscale code, $V_{DD} = 5\text{ V} \pm 5\%$ , $V_{CC} = 20\text{ V}$ , $V_{SS} = -20\text{ V}$                                                                                               |     | 1    |     | LSB/V                  |
|                            |                                 | Midscale code, $V_{DD} = 5\text{ V}$ , $V_{CC} = 20\text{ V} \pm 5\%$ , $V_{SS} = -20\text{ V}$                                                                                               |     | 1    |     |                        |
|                            |                                 | Midscale code, $V_{DD} = 5\text{ V}$ , $V_{CC} = 20\text{ V}$ , $V_{SS} = -20\text{ V} \pm 5\%$                                                                                               |     | 1    |     |                        |
|                            | Code change glitch impulse      | 1 LSB change around major carrier, 0 to 5 V range                                                                                                                                             |     | 4    |     | $\text{nV-s}$          |
|                            | Channel to Channel AC crosstalk | 0 to 5 V range. Measured channel at midscale. Full-scale swing on all other channels                                                                                                          |     | 4    |     | $\text{nV-s}$          |
|                            | Channel to Channel DC crosstalk | 0 to 5 V range. Measured channel at midscale. All other channels at full-scale                                                                                                                |     | 0.25 |     | LSB                    |
|                            | Digital feedthrough             | 0 to 5 V range. Midscale code, $f_{\text{SCLK}} = 1\text{ MHz}$                                                                                                                               |     | 1    |     | $\text{nV-s}$          |

## Electrical Characteristics (continued)

all minimum/maximum specifications at  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  and all typical specifications at  $T_A = 25^{\circ}\text{C}$ ,  $V_{CC} = 9\text{ V}$  to  $41.5\text{ V}$ ,  $V_{SS} = -21.5\text{ V}$  to  $0\text{ V}$ ,  $V_{DD} = V_{AA} = 4.5\text{ V}$  to  $5.5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ ,  $V_{IO} = 1.7\text{ V}$  to  $5.5\text{ V}$ , DAC outputs unloaded, Digital inputs at  $V_{IO}$  or GND (unless otherwise noted)

| PARAMETER                  |                                  | TEST CONDITIONS                     | MIN                   | TYP  | MAX    | UNIT   |
|----------------------------|----------------------------------|-------------------------------------|-----------------------|------|--------|--------|
| EXTERNAL REFERENCE INPUT   |                                  |                                     |                       |      |        |        |
| V <sub>REFIN</sub>         | Reference input voltage range    | to V <sub>REFGND</sub>              | 2.49                  | 2.5  | 2.51   | V      |
|                            | Reference input current          |                                     |                       | 50   |        | μA     |
|                            | Reference input impedance        |                                     |                       | 50   |        | kΩ     |
|                            | Reference input capacitance      |                                     |                       | 20   |        | pF     |
| INTERNAL REFERENCE         |                                  |                                     |                       |      |        |        |
| V <sub>REFOUT</sub>        | Reference output voltage range   | T <sub>A</sub> = 25°C               | 2.4975                |      | 2.5025 | V      |
|                            | Reference output drift           |                                     |                       | 5    | 15     | ppm/°C |
|                            | Reference output impedance       |                                     |                       | 0.1  |        | Ω      |
|                            | Reference output noise           | 0.1 Hz to 10 Hz                     |                       | 12   |        | μVpp   |
|                            | Reference output noise density   | 10 kHz, REF <sub>LOAD</sub> = 10 nF |                       | 150  |        | nV/Hz  |
|                            | Reference load current           |                                     |                       | 5    |        | mA     |
|                            | Reference load regulation        | Source                              |                       | 80   |        | μV/mA  |
|                            | Reference line regulation        |                                     |                       | 20   |        | μV/V   |
|                            | Reference output drift over time | T <sub>A</sub> = 25°C, 1900 hours   |                       | 250  |        | μV     |
|                            | Reference thermal hysteresis     | First cycle                         |                       | ±700 |        | μV     |
|                            |                                  | Additional cycle                    |                       | ±50  |        |        |
| DIGITAL INPUTS AND OUTPUTS |                                  |                                     |                       |      |        |        |
| V <sub>IH</sub>            | High-level input voltage         |                                     | 0.7 × V <sub>IO</sub> |      |        | V      |
| V <sub>IL</sub>            | Low-level input voltage          |                                     | 0.3 × V <sub>IO</sub> |      |        | V      |
|                            | Input current                    |                                     | ±2                    |      |        | μA     |
|                            | Input pin capacitance            |                                     | 2                     |      |        | pF     |
| V <sub>OH</sub>            | High-level output voltage        | I <sub>OH</sub> = 0.2 mA            | V <sub>IO</sub> - 0.2 |      |        | V      |
| V <sub>OL</sub>            | Low-level output voltage         | I <sub>OL</sub> = 0.2 mA            | 0.4                   |      |        | V      |
|                            | Output pin capacitance           |                                     | 5                     |      |        | pF     |
| ALARM OUTPUT               |                                  |                                     |                       |      |        |        |
|                            | Output pin capacitance           |                                     | 5                     |      |        | pF     |
| V <sub>OL</sub>            | Low-level output voltage         | I <sub>LOAD</sub> = -0.2 mA         | 0.4                   |      |        | V      |
| TEMPERATURE OUTPUT         |                                  |                                     |                       |      |        |        |
| V <sub>TEMPOUT,0C</sub>    | Output voltage offset at 0°C     |                                     | 1.34                  |      |        | V      |
|                            | Sensor gain                      |                                     | -4                    |      |        | mV/°C  |

**DAC81408, DAC71408, DAC61408**

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**Electrical Characteristics (continued)**

all minimum/maximum specifications at  $T_A = -40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$  and all typical specifications at  $T_A = 25^{\circ}\text{C}$ ,  $V_{CC} = 9\text{ V}$  to  $41.5\text{ V}$ ,  $V_{SS} = -21.5\text{ V}$  to  $0\text{ V}$ ,  $V_{DD} = V_{AA} = 4.5\text{ V}$  to  $5.5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ ,  $V_{IO} = 1.7\text{ V}$  to  $5.5\text{ V}$ , DAC outputs unloaded, Digital inputs at  $V_{IO}$  or GND (unless otherwise noted)

| PARAMETER                 |                         | TEST CONDITIONS                                                                                        | MIN | TYP  | MAX | UNIT          |
|---------------------------|-------------------------|--------------------------------------------------------------------------------------------------------|-----|------|-----|---------------|
| <b>POWER REQUIREMENTS</b> |                         |                                                                                                        |     |      |     |               |
| $I_{DD}$                  | $V_{DD}$ supply current | Active mode. Internal reference enabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static.  |     | 0.05 | 0.5 | mA            |
|                           |                         | Active mode. Internal reference disabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static. |     | 0.05 | 0.5 | mA            |
|                           |                         | Power-down mode                                                                                        |     | 0.05 | 0.5 | mA            |
| $I_{AA}$                  | $V_{AA}$ supply current | Active mode. Internal reference enabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static.  |     | 20   | 30  | mA            |
|                           |                         | Active mode. Internal reference disabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static. |     | 18   | 28  | mA            |
|                           |                         | Power-down mode                                                                                        |     | 2    | 85  | $\mu\text{A}$ |
| $I_{CC}$                  | $V_{CC}$ supply current | Active mode. Internal reference enabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static.  |     | 5    | 10  | mA            |
|                           |                         | Active mode. Internal reference disabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static. |     | 5    | 10  | mA            |
|                           |                         | Power-down mode                                                                                        |     | 10   | 30  | $\mu\text{A}$ |
| $I_{SS}$                  | $V_{SS}$ supply current | Active mode. Internal reference enabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static.  | -10 | -5   |     | mA            |
|                           |                         | Active mode. Internal reference disabled. Full-scale code. $\pm 20\text{ V}$ output range. SPI static. | -10 | -5   |     | mA            |
|                           |                         | Power-down mode                                                                                        | -30 | -10  |     | $\mu\text{A}$ |
| $I_{IO}$                  | $V_{IO}$ supply current | SCLK and SDI toggling at 50 MHz                                                                        |     | 350  | 500 | $\mu\text{A}$ |

## 7.6 Timing Requirements

over operating free-air temperature range (unless otherwise noted)

|                                                             |                                                         |                                  | MIN | NOM | MAX | UNIT |
|-------------------------------------------------------------|---------------------------------------------------------|----------------------------------|-----|-----|-----|------|
| SERIAL INTERFACE - WRITE OPERATION                          |                                                         |                                  |     |     |     |      |
| f <sub>(SCLK)</sub>                                         | Serial clock frequency                                  | V <sub>IO</sub> = 1.7 V to 2.7 V |     |     | 25  | MHz  |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V |     |     | 50  |      |
| t <sub>SCLKHIGH</sub>                                       | SCLK high time                                          | V <sub>IO</sub> = 1.7 V to 2.7 V | 20  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 10  |     |     |      |
| t <sub>SCLKLOW</sub>                                        | SCLK low time                                           | V <sub>IO</sub> = 1.7 V to 2.7 V | 20  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 10  |     |     |      |
| t <sub>SDIS</sub>                                           | SDI setup time                                          | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>SDIH</sub>                                           | SDI hold time                                           | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>CSS</sub>                                            | $\overline{\text{CS}}$ to SCLK falling edge setup time  | V <sub>IO</sub> = 1.7 V to 2.7 V | 30  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 15  |     |     |      |
| t <sub>CSH</sub>                                            | SCLK falling edge to $\overline{\text{CS}}$ rising edge | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>CSHIGH</sub>                                         | $\overline{\text{CS}}$ hight time                       | V <sub>IO</sub> = 1.7 V to 2.7 V | 50  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 25  |     |     |      |
| t <sub>DACWAIT</sub>                                        | Sequential DAC update wait time                         | V <sub>IO</sub> = 1.7 V to 2.7 V | 2.4 |     |     | μs   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 2.4 |     |     |      |
| t <sub>BCASTWAIT</sub>                                      | Broadcast DAC update wait time                          | V <sub>IO</sub> = 1.7 V to 2.7 V | 4   |     |     | μs   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 4   |     |     |      |
| SERIAL INTERFACE - READ AND DAISY CHAIN OPERATION, FSDO = 0 |                                                         |                                  |     |     |     |      |
| f <sub>(SCLK)</sub>                                         | Serial clock frequency                                  | V <sub>IO</sub> = 1.7 V to 2.7 V |     |     | 15  | MHz  |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V |     |     | 20  |      |
| t <sub>SCLKHIGH</sub>                                       | SCLK high time                                          | V <sub>IO</sub> = 1.7 V to 2.7 V | 33  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 25  |     |     |      |
| t <sub>SCLKLOW</sub>                                        | SCLK low time                                           | V <sub>IO</sub> = 1.7 V to 2.7 V | 33  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 25  |     |     |      |
| t <sub>SDIS</sub>                                           | SDI setup time                                          | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>SDIH</sub>                                           | SDI hold time                                           | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>CSS</sub>                                            | $\overline{\text{CS}}$ to SCLK falling edge setup time  | V <sub>IO</sub> = 1.7 V to 2.7 V | 30  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 20  |     |     |      |
| t <sub>CSH</sub>                                            | SCLK falling edge to $\overline{\text{CS}}$ rising edge | V <sub>IO</sub> = 1.7 V to 2.7 V | 8   |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>CSHIGH</sub>                                         | $\overline{\text{CS}}$ high time                        | V <sub>IO</sub> = 1.7 V to 2.7 V | 50  |     |     | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 25  |     |     |      |
| t <sub>SDOZD</sub>                                          | SDO tri-state to driven                                 | V <sub>IO</sub> = 1.7 V to 2.7 V | 0   |     | 20  | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 0   |     | 20  |      |
| t <sub>SDODLY</sub>                                         | SDO output delay                                        | V <sub>IO</sub> = 1.7 V to 2.7 V | 0   |     | 35  | ns   |
|                                                             |                                                         | V <sub>IO</sub> = 2.7 V to 5.5 V | 0   |     | 20  |      |

## Timing Requirements (continued)

over operating free-air temperature range (unless otherwise noted)

|                                                             |                                                                                                                   |                                  | MIN | NOM | MAX | UNIT |
|-------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------|----------------------------------|-----|-----|-----|------|
| SERIAL INTERFACE - READ AND DAISY CHAIN OPERATION, FSDO = 1 |                                                                                                                   |                                  |     |     |     |      |
| f(SCLK)                                                     | Serial clock frequency                                                                                            | V <sub>IO</sub> = 1.7 V to 2.7 V |     |     | 25  | MHz  |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V |     |     | 35  |      |
| t <sub>SCLKHIGH</sub>                                       | SCLK high time                                                                                                    | V <sub>IO</sub> = 1.7 V to 2.7 V | 20  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 14  |     |     |      |
| t <sub>SCLKLOW</sub>                                        | SCLK low time                                                                                                     | V <sub>IO</sub> = 1.7 V to 2.7 V | 20  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 14  |     |     |      |
| t <sub>SDIS</sub>                                           | SDI setup time                                                                                                    | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>SDIH</sub>                                           | SDI hold time                                                                                                     | V <sub>IO</sub> = 1.7 V to 2.7 V | 10  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>CSS</sub>                                            | $\overline{\text{CS}}$ to SCLK falling edge setup time                                                            | V <sub>IO</sub> = 1.7 V to 2.7 V | 30  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 20  |     |     |      |
| t <sub>CSH</sub>                                            | SCLK falling edge to $\overline{\text{CS}}$ rising edge                                                           | V <sub>IO</sub> = 1.7 V to 2.7 V | 8   |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 5   |     |     |      |
| t <sub>CSHIGH</sub>                                         | $\overline{\text{CS}}$ high time                                                                                  | V <sub>IO</sub> = 1.7 V to 2.7 V | 50  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 25  |     |     |      |
| t <sub>SDOZD</sub>                                          | SDO tri-state to driven                                                                                           | V <sub>IO</sub> = 1.7 V to 2.7 V | 0   |     | 20  | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 0   |     | 20  |      |
| t <sub>SDODLY</sub>                                         | SDO output delay                                                                                                  | V <sub>IO</sub> = 1.7 V to 2.7 V | 0   |     | 35  | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 0   |     | 20  |      |
| DIGITAL LOGIC                                               |                                                                                                                   |                                  |     |     |     |      |
| t <sub>LOGDLY</sub>                                         | $\overline{\text{CS}}$ rising edge to $\overline{\text{LDAC}}$ or $\overline{\text{CLR}}$ falling edge delay time | V <sub>IO</sub> = 1.7 V to 2.7 V | 40  |     |     | ns   |
| t <sub>LOGDLY</sub>                                         | $\overline{\text{CS}}$ rising edge to $\overline{\text{LDAC}}$ or $\overline{\text{CLR}}$ falling edge delay time | V <sub>IO</sub> = 2.7 V to 5.5 V | 20  |     |     |      |
| t <sub>LDAC</sub>                                           | $\overline{\text{LDAC}}$ low time                                                                                 | V <sub>IO</sub> = 1.7 V to 2.7 V | 20  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 10  |     |     |      |
| t <sub>CLR</sub>                                            | $\overline{\text{CLR}}$ low time                                                                                  | V <sub>IO</sub> = 1.7 V to 2.7 V | 20  |     |     | ns   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V | 10  |     |     |      |
| t <sub>RESET</sub>                                          | POR reset delay                                                                                                   | V <sub>IO</sub> = 1.7 V to 2.7 V |     |     | 1   | ms   |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V |     |     | 1   |      |
| f <sub>TOGGLE</sub>                                         | TOGGLE frequency                                                                                                  | V <sub>IO</sub> = 1.7 V to 2.7 V |     |     | 100 | kHz  |
|                                                             |                                                                                                                   | V <sub>IO</sub> = 2.7 V to 5.5 V |     |     | 100 |      |

## 7.7 Typical Characteristics

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.

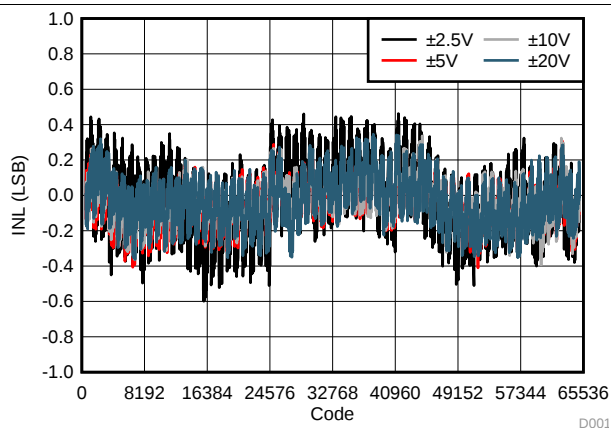


图 1. Integral Linearity Error vs Digital Input Code (Bipolar Outputs)

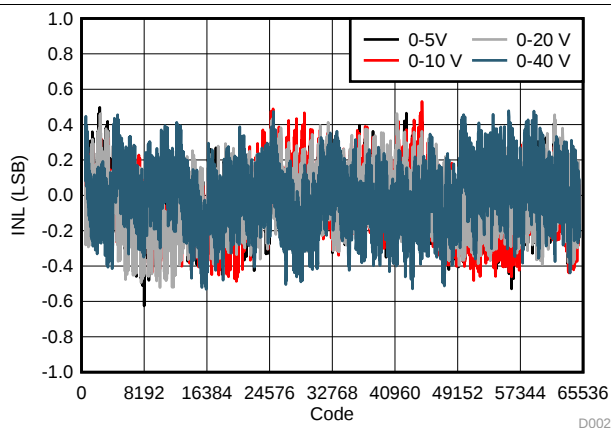


图 2. Integral Linearity Error vs Digital Input Code (Unipolar Outputs)

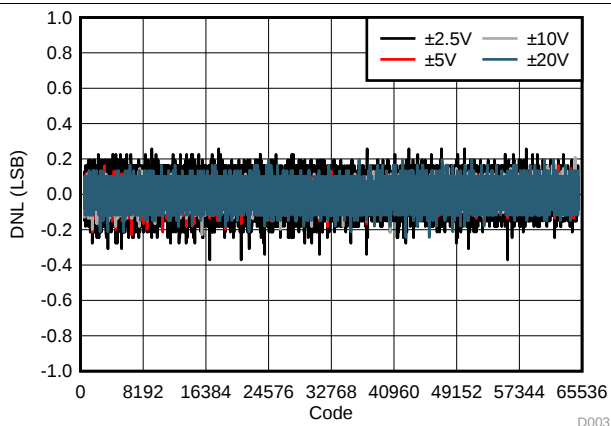


图 3. Differential Linearity Error vs Digital Input Code (Bipolar Outputs)

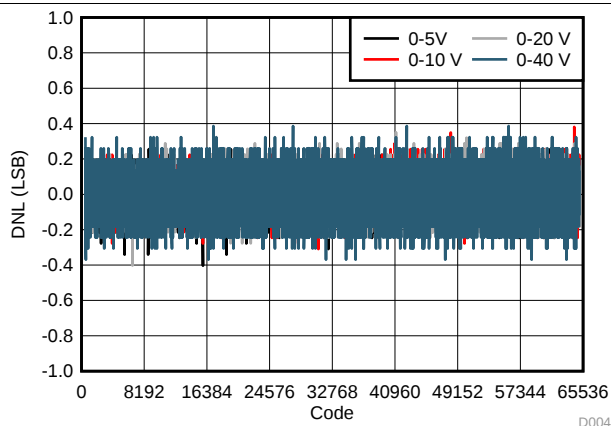


图 4. Differential Linearity Error vs Digital Input Code (Unipolar Outputs)

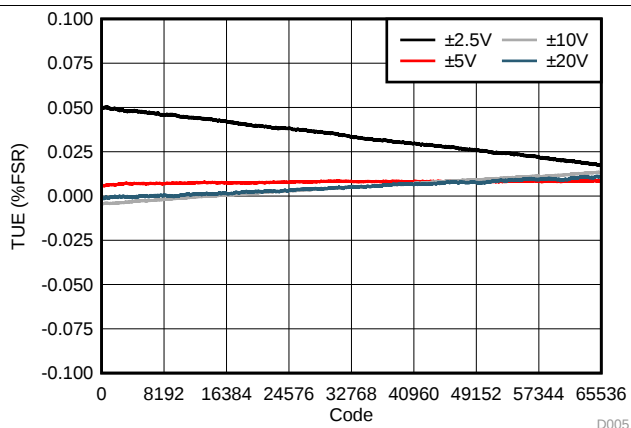


图 5. Total Unadjusted Error vs Digital Input Code (Bipolar Outputs)

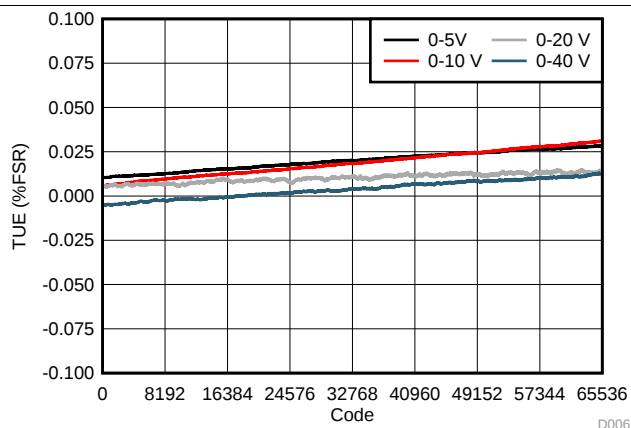


图 6. Total Unadjusted Error vs Digital Input Code (Unipolar Outputs)

## Typical Characteristics (接下页)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.

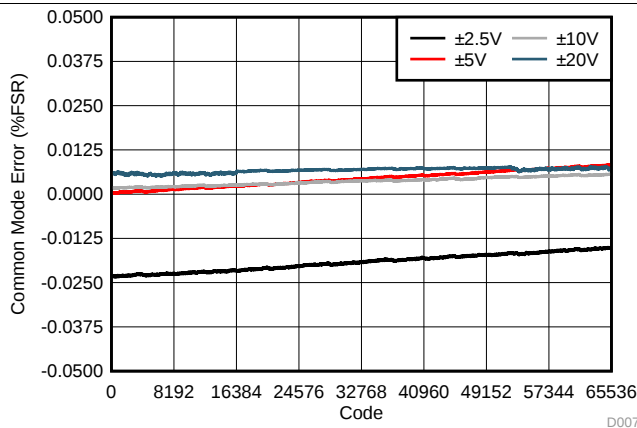


图 7. Common Mode Error vs Digital Input Code (Differential Bipolar Outputs)

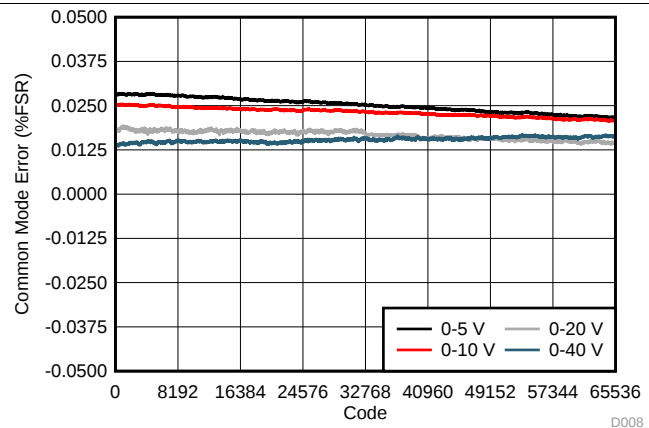
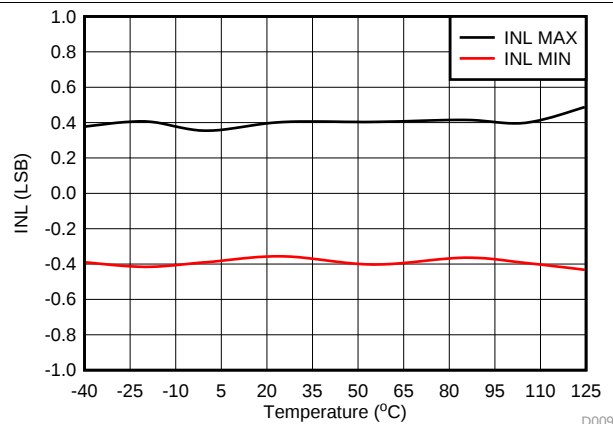
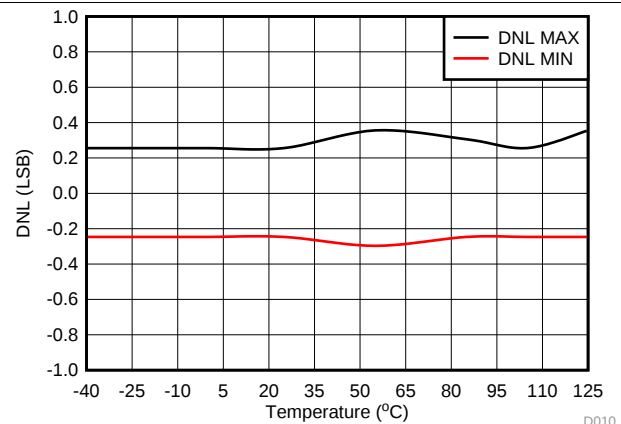


图 8. Common Mode Error vs Digital Input Code (Differential Unipolar Outputs)



±20-V Output Range

图 9. Integral Linearity Error vs Temperature



±20-V Output Range

图 10. Differential Linearity Error vs Temperature

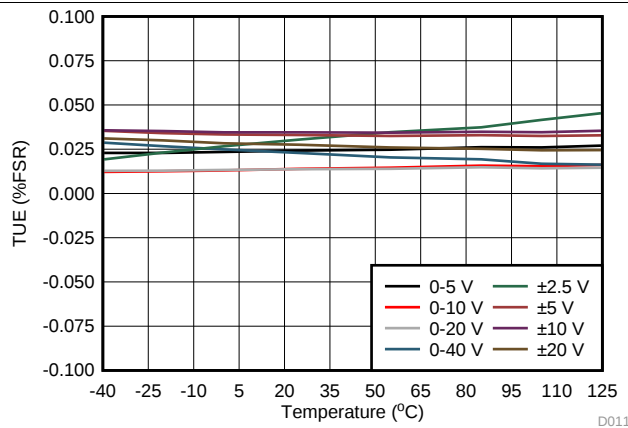


图 11. Total Unadjusted Error vs Temperature

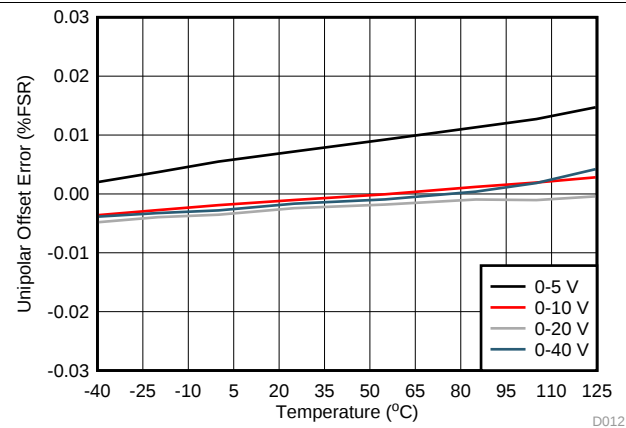


图 12. Unipolar Offset Error vs Temperature

## Typical Characteristics (接下页)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.

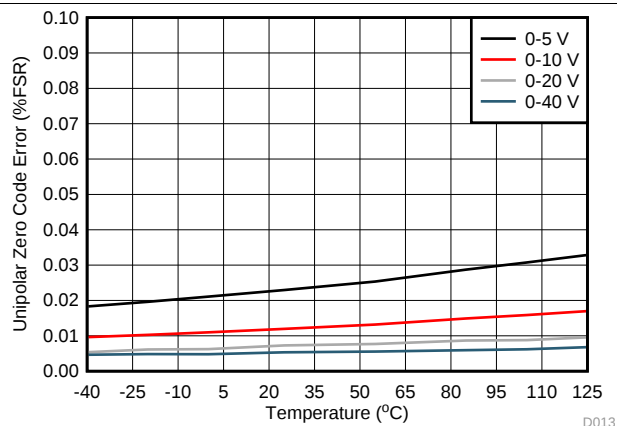


图 13. Unipolar Zero Code Error vs Temperature

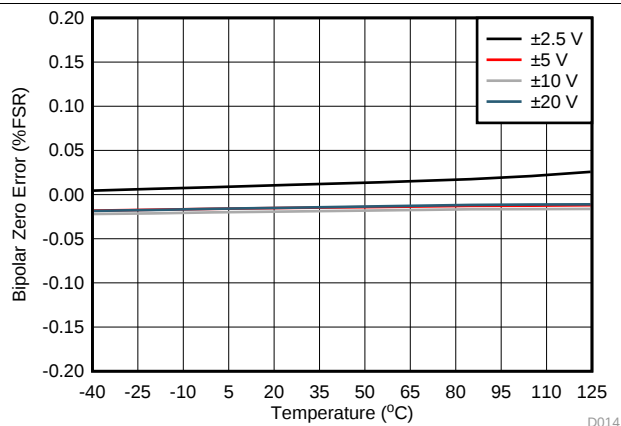


图 14. Bipolar Zero Error vs Temperature

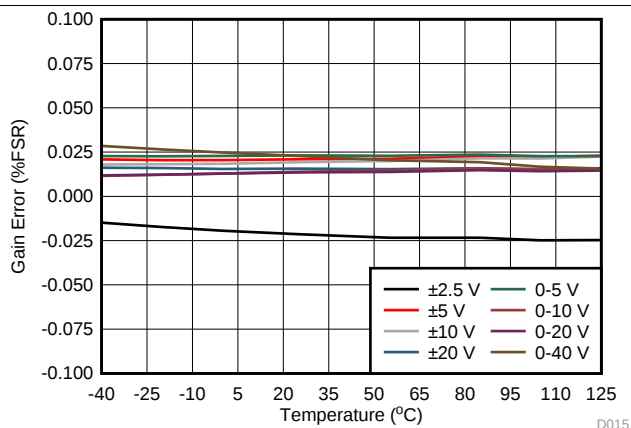


图 15. Gain Error vs Temperature

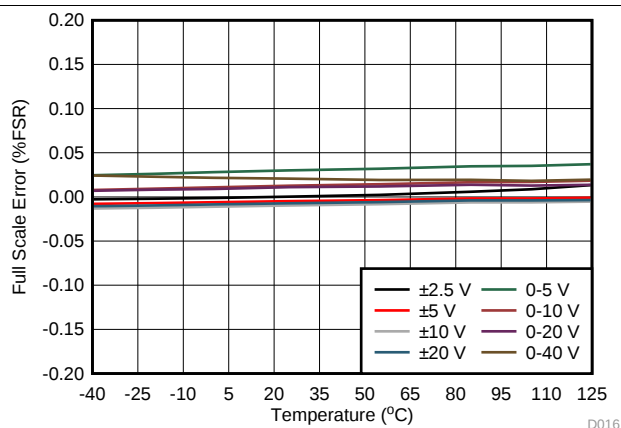


图 16. Full-Scale Error vs Temperature

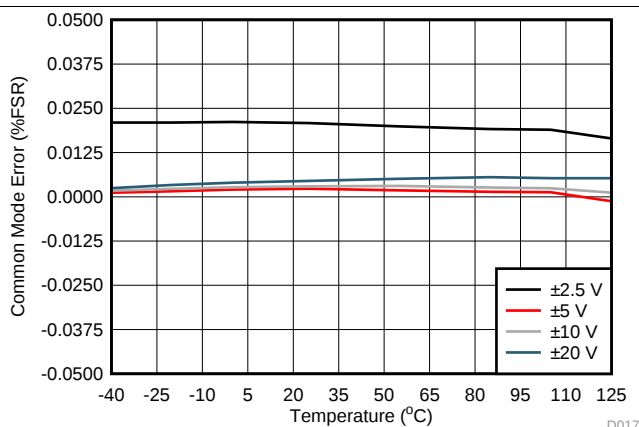


图 17. Common Mode Error vs Temperature (Differential Bipolar Outputs)

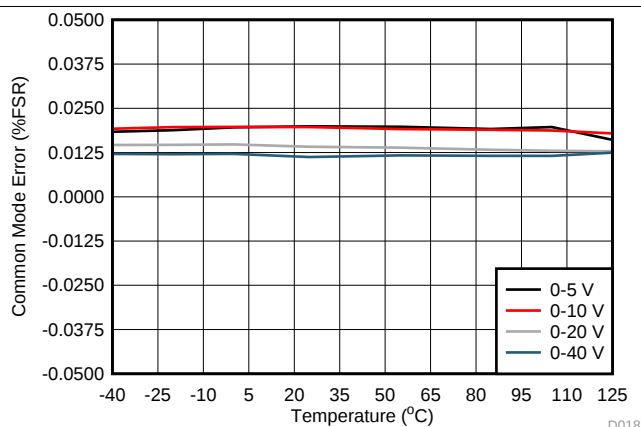


图 18. Common Mode Error vs Temperature (Differential Unipolar Outputs)

## Typical Characteristics (接下页)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.

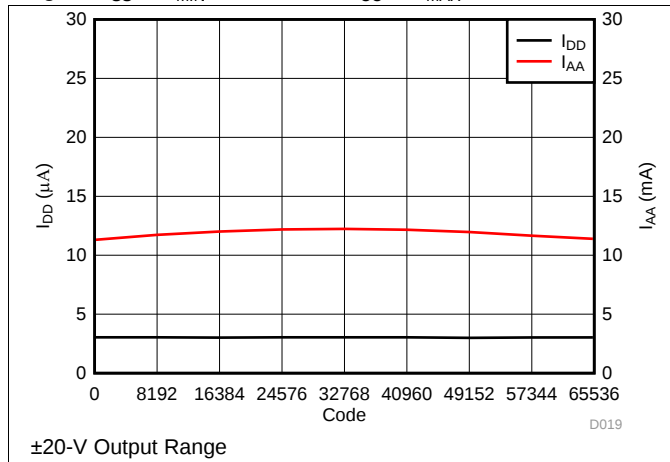


图 19. Supply Current ( $I_{DD}$ ,  $I_{AA}$ ) vs Digital Input Code

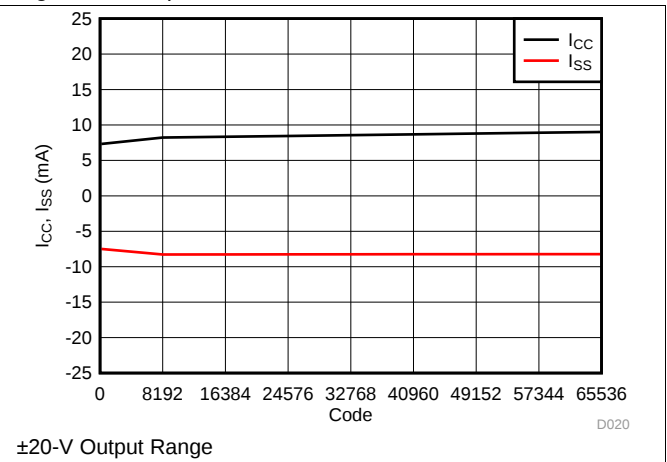


图 20. Supply Current ( $I_{CC}$ ,  $I_{SS}$ ) vs Digital Input Code

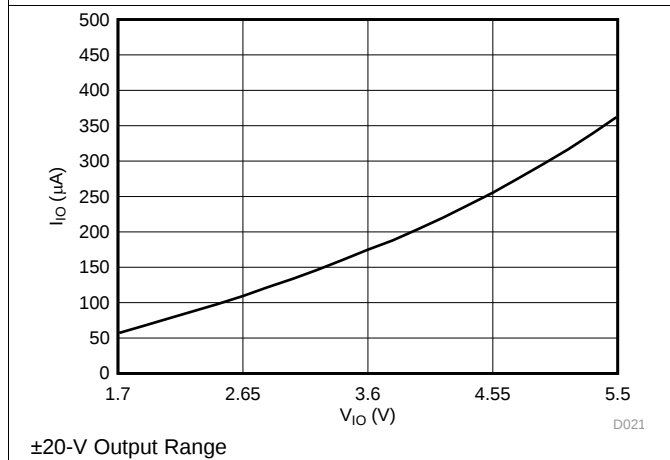


图 21. Supply Current ( $I_{IO}$ ) vs Supply Voltage

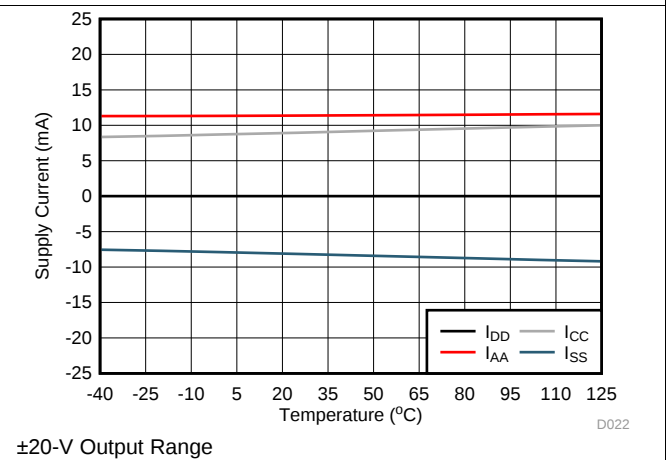


图 22. Supply Current vs Temperature

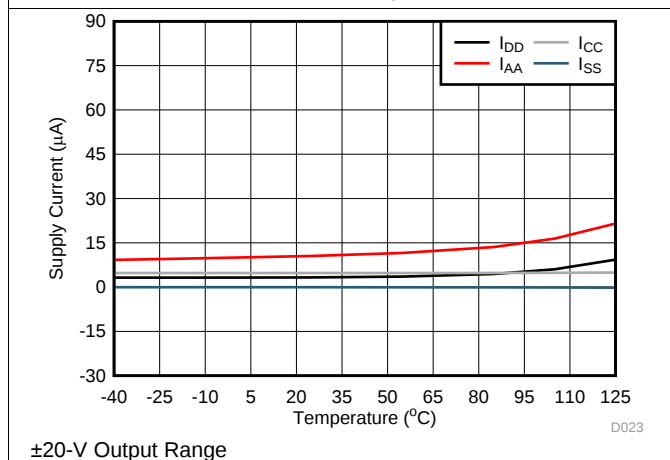


图 23. Power-Down Current vs Temperature

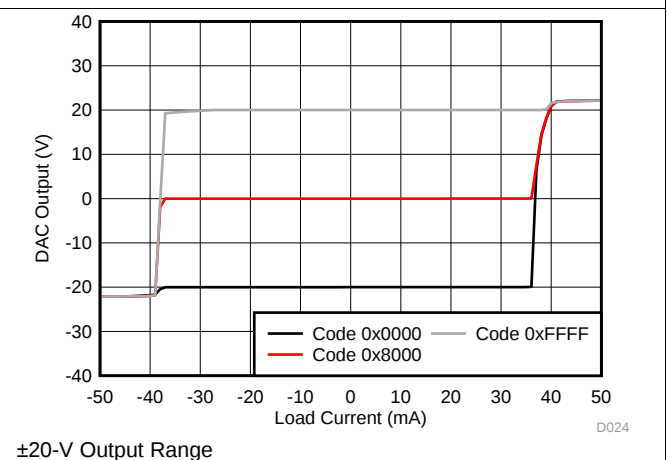
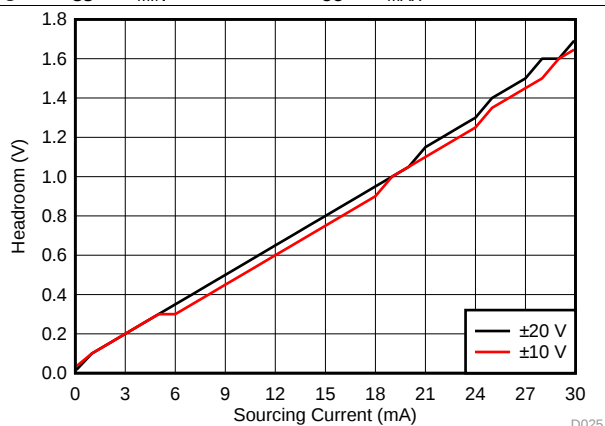


图 24. Source and Sink Capability

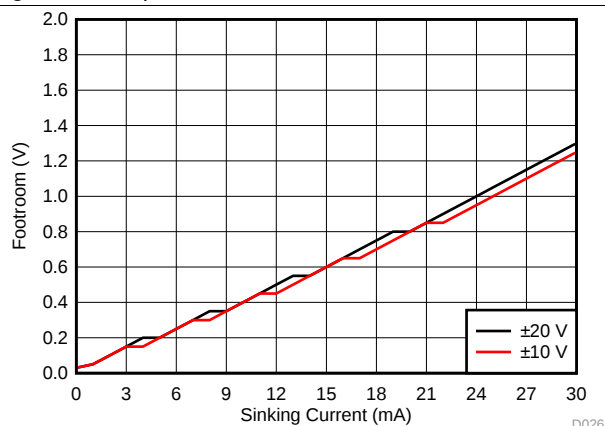
## Typical Characteristics (接下页)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.



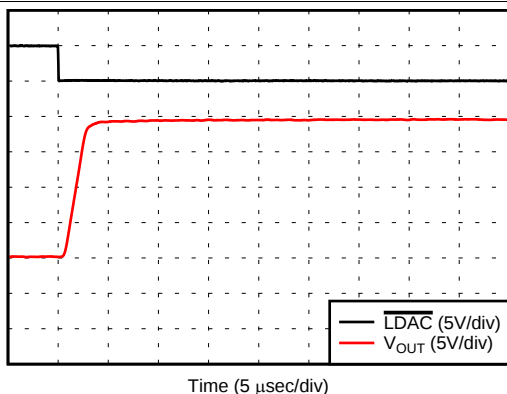
Full-scale Code

图 25.  $V_{CC}$  Headroom vs Sourcing Current



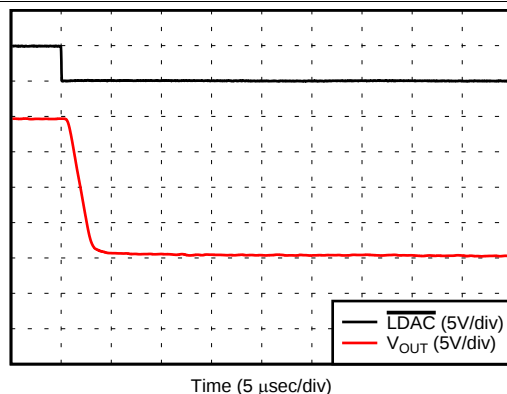
Zero Code

图 26.  $V_{SS}$  Footroom vs Sinking Current



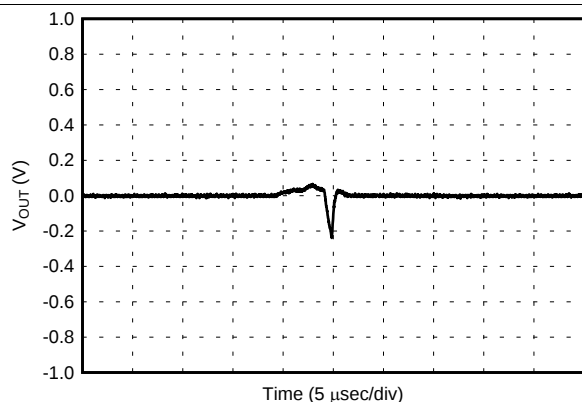
±20-V Output Range

图 27. Full-Scale Settling Time, Rising Edge



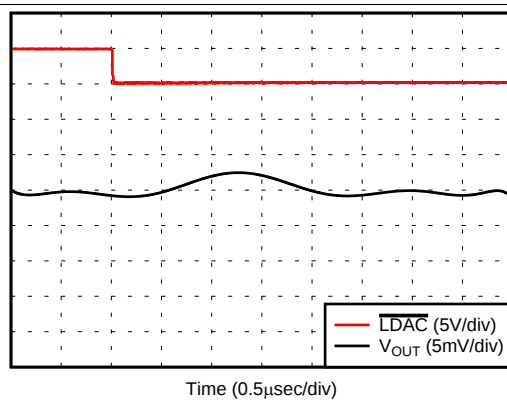
±20-V Output Range

图 28. Full-Scale Settling Time, Falling Edge



Power-down to Active DAC Mode  
±20-V Output Range

图 29. DAC Output Enable Glitch

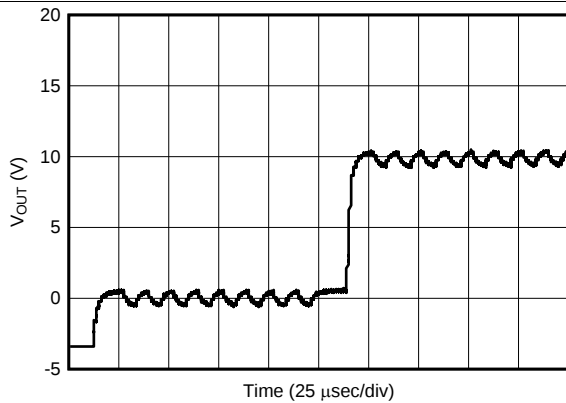


0 to 5-V Output Range

图 30. Glitch Impulse, 1 LSB Step

## Typical Characteristics (接下页)

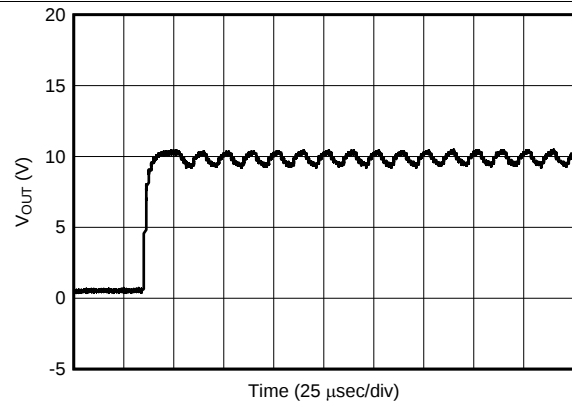
at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.



D031

±20-V Output Range  
Toggle signal: 1 V<sub>PP</sub>  
DC Change: Midscale to 3/4 Full-scale

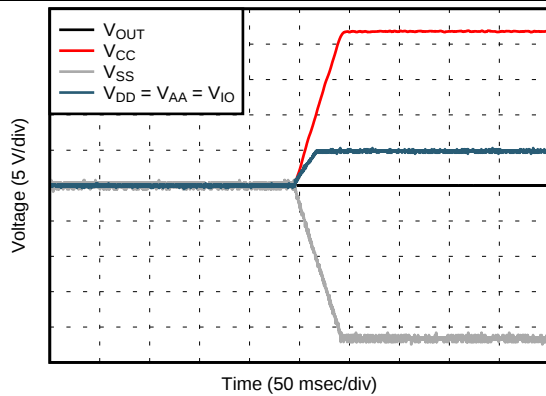
图 31. Toggle Output Change Response



D032

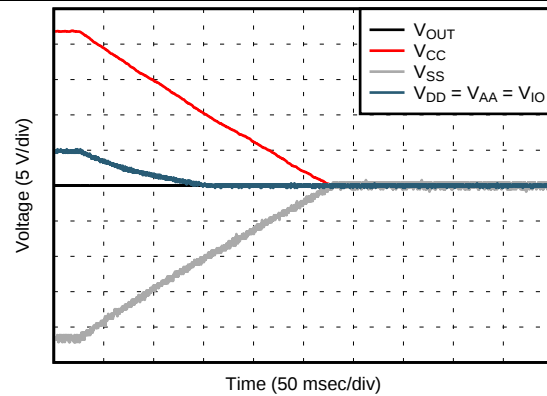
±20-V Output Range  
Toggle signal: 1 V<sub>PP</sub>  
DC value: 3/4 Full-scale

图 32. Toggle Enable Response



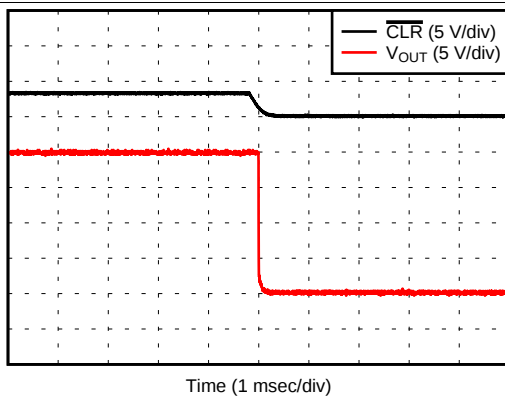
D033

图 33. Power-Up Response



D034

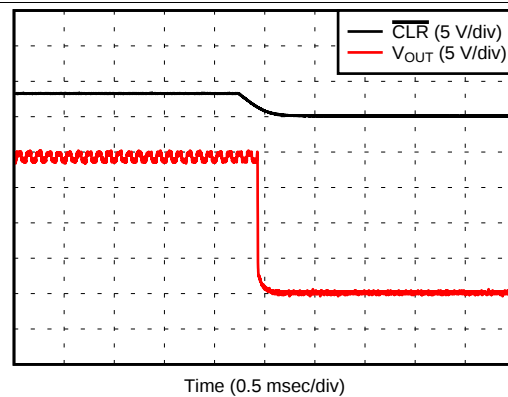
图 34. Power-Down Response



D035

±20-V Output Range  
Full-scale Code to 0 V

图 35. Clear Command Response



D036

±20-V Output Range  
Toggle signal: 1 V<sub>PP</sub>  
DC value at 20 V

图 36. Clear Command Response in Toggle Mode

## Typical Characteristics (接下页)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.

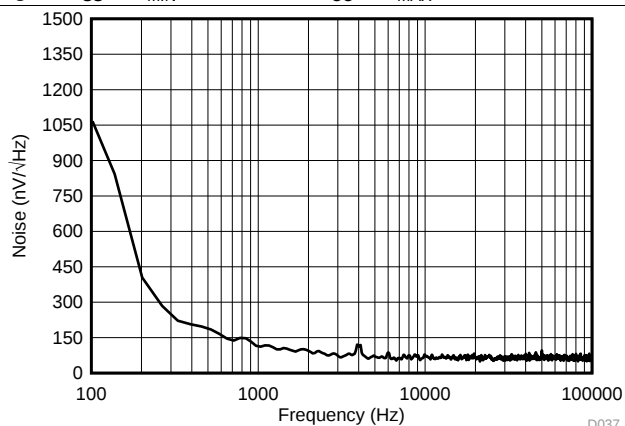


图 37. DAC Output Noise Density vs Frequency

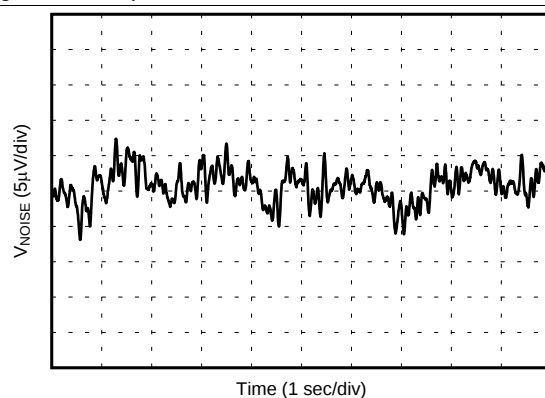


图 38. DAC Output Noise

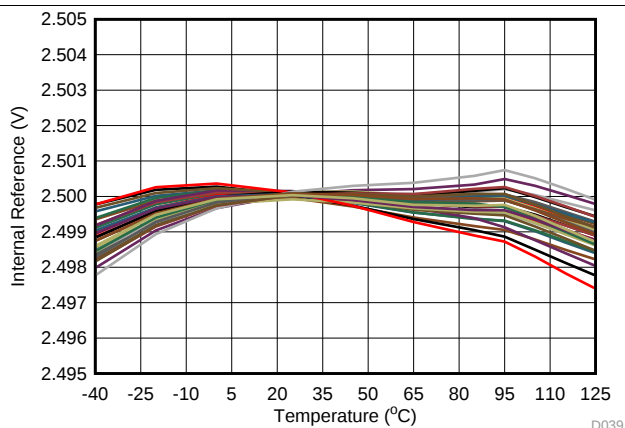


图 39. Internal Reference Voltage vs Temperature

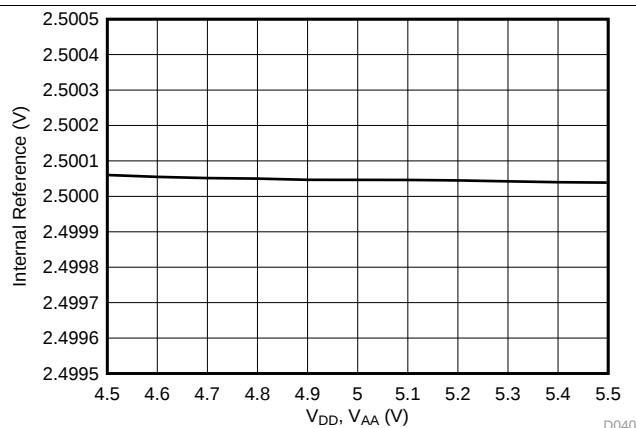


图 40. Internal Reference Voltage vs Supply Voltage

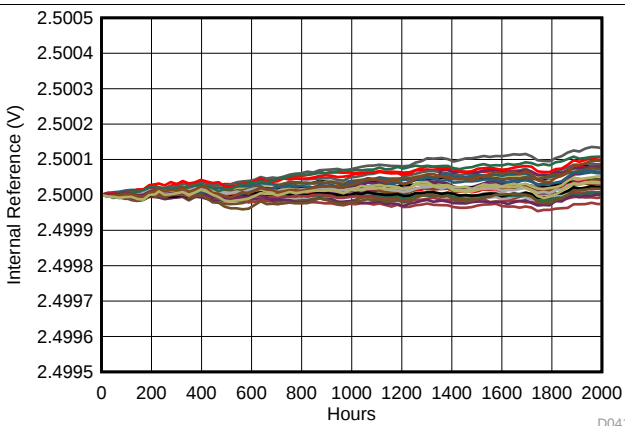


图 41. Internal Reference Voltage vs Time

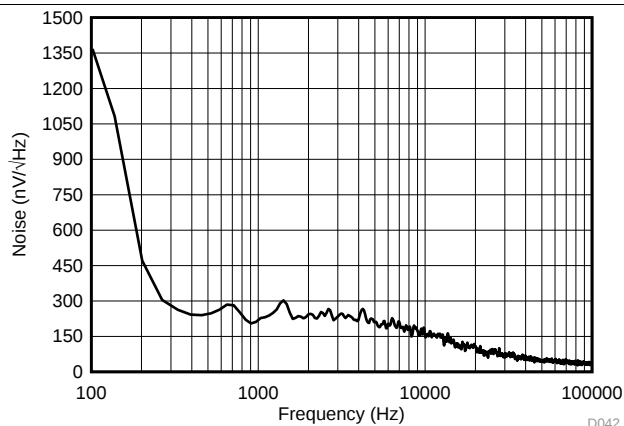
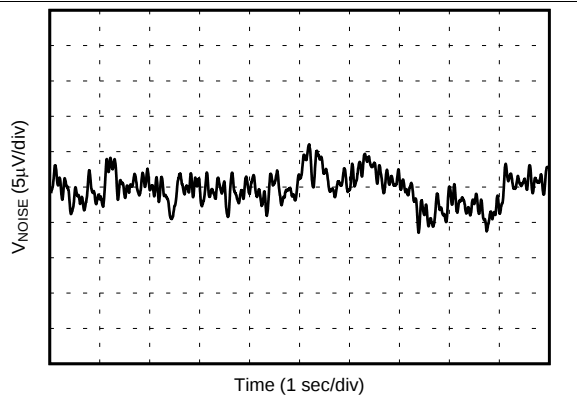


图 42. Internal Reference Noise Density vs Frequency

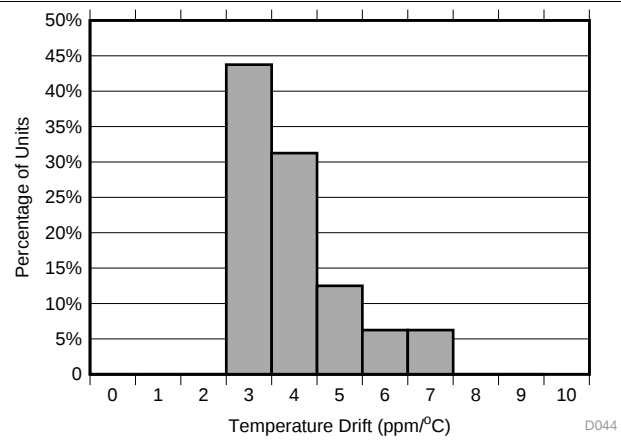
## Typical Characteristics (接下页)

at  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = V_{AA} = 5\text{ V}$ ,  $V_{REFIN} = 2.5\text{ V}$ . Unipolar ranges:  $V_{SS} = 0\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. Bipolar ranges:  $V_{SS} \leq V_{MIN} - 1.5\text{ V}$  and  $V_{CC} \geq V_{MAX} + 1.5\text{ V}$  for the DAC range. DAC outputs unloaded, unless otherwise noted.



D043

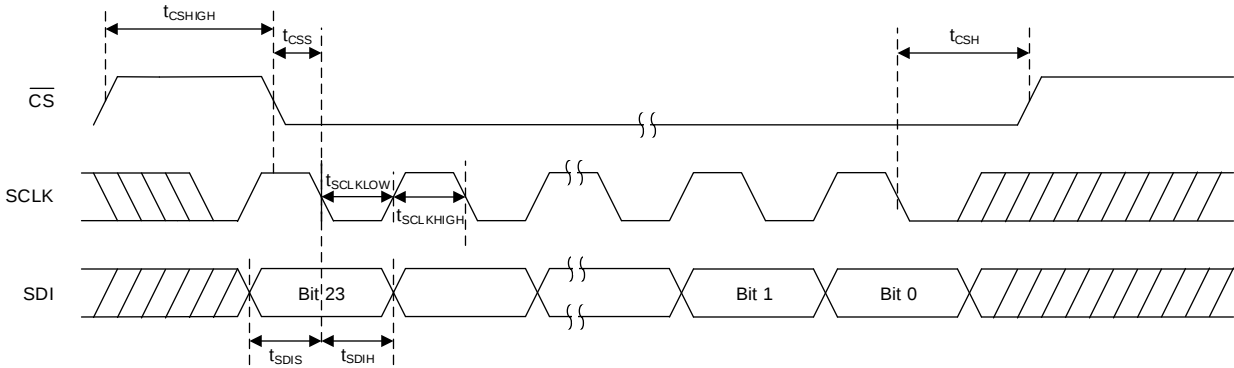
图 43. Internal Reference Noise



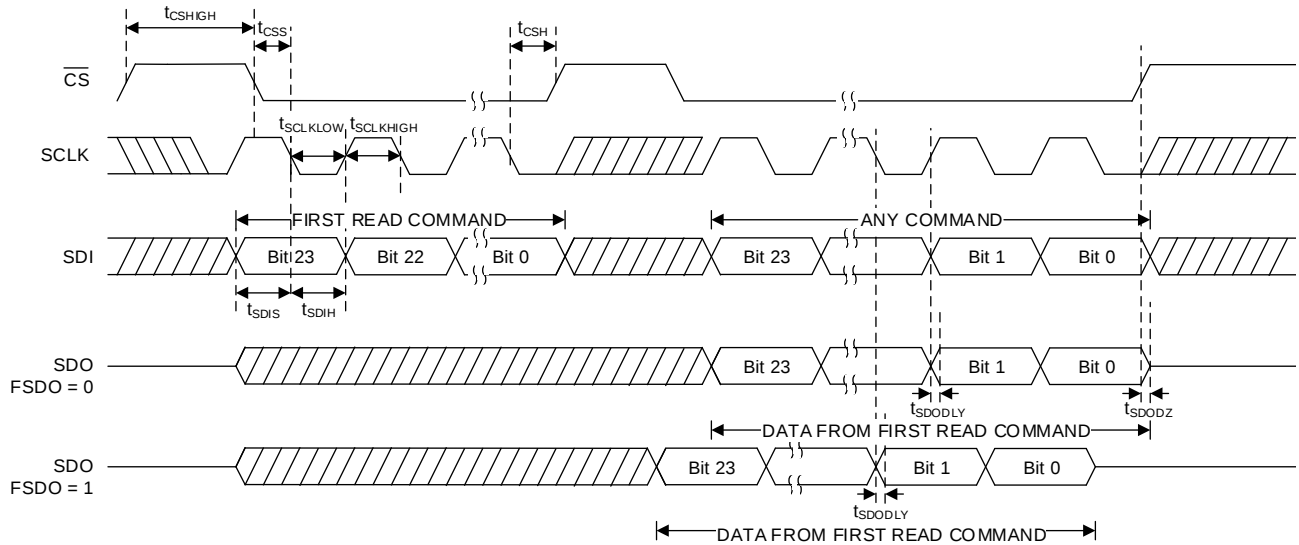
D044

图 44. Internal Reference Temperature Drift Histogram

## 8 Parameter Measurement Information



**图 45. Serial Interface Write Timing Diagram**



**图 46. Serial Interface Read Timing Diagram**

## 9 Detailed Description

### 9.1 Overview

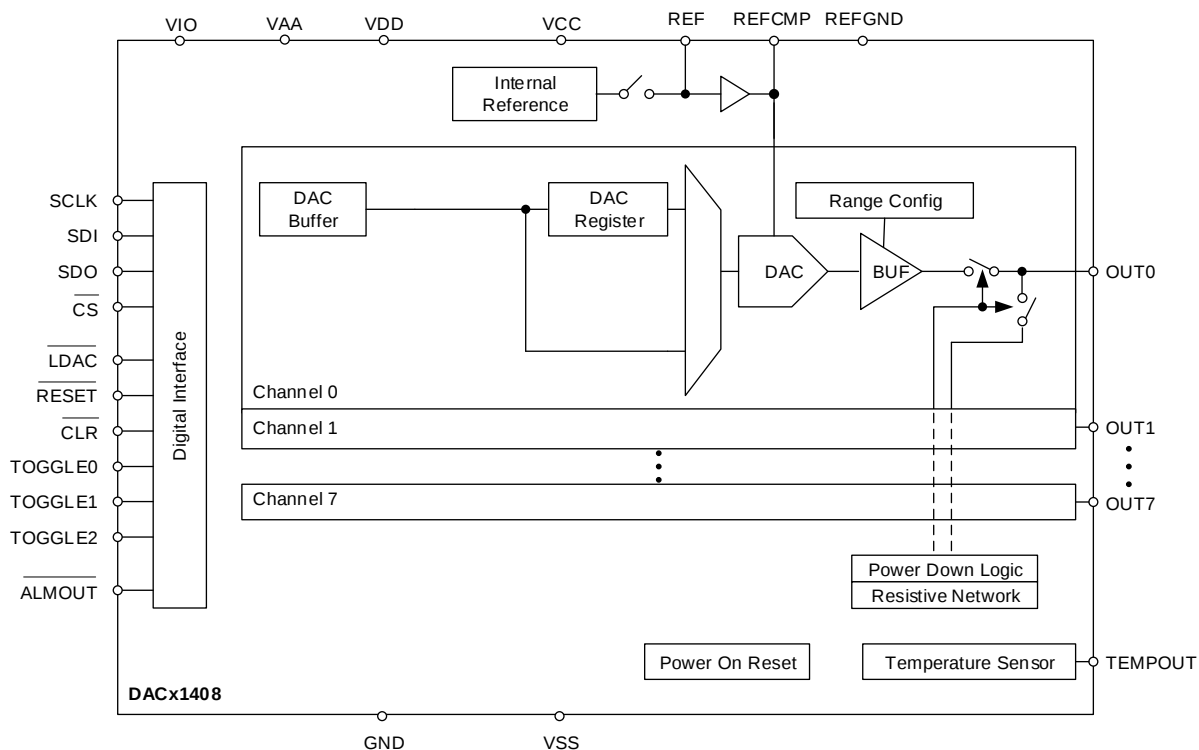
The DACx1408 is a pin-compatible family of 8-channel, buffered, high-voltage output digital-to-analog converters (DACs) with 16-, 14- and 12-bit resolution. The DACx1408 includes a 2.5-V internal reference. A user selectable output configuration enables full-scale bipolar output voltages:  $\pm 20$  V,  $\pm 10$  V,  $\pm 5$  V or  $\pm 2.5$  V and full-scale unipolar output voltages: 40 V, 20 V, 10 V or 5 V. The full-scale output range for each DAC channel is independently programmable. In addition, each pair of DAC channels can be configured to provide a differential output. Three dedicated A-B toggle pins enable dither signal generation with up to three possible frequencies.

The DACx1408 operates from five supply voltages:  $V_{DD}$ ,  $V_{AA}$ ,  $V_{CC}$ ,  $V_{SS}$  and  $V_{IO}$ .  $V_{DD}$  and  $V_{AA}$  are the digital and analog supplies for the DACs, internal reference and other low voltage components and must be set at the same potential.  $V_{CC}$  and  $V_{SS}$  are the positive and analog supplies for the DAC output amplifiers.  $V_{IO}$  sets the logic levels for the digital inputs and outputs.

Communication to the DACx1408 is performed through a 4-wire serial interface that supports stand-alone and daisy-chain operation. The optional frame-error checking provides added robustness to the DACx1408 serial interface.

The DACx1408 incorporates a power-on-reset circuit that connects the DAC outputs to ground at power-up. The outputs remain at this state until the device registers are properly configured for operation.

### 9.2 Functional Block Diagram



## 9.3 Feature Description

### 9.3.1 Digital-to-Analog Converters (DACs) Architecture

Each output channel in the DACx1408 consists of an R-2R ladder architecture followed by an output buffer amplifier capable of rail-to-rail operation. The output amplifiers can drive 25 mA with 1.5-V headroom from either  $V_{CC}$  or  $V_{SS}$  while maintaining the specified TUE specification for the device. The full-scale output voltage for each channel can be individually configured to the following ranges:

- -20 V to +20 V
- -10 V to +10 V
- -5 V to +5 V
- -2.5 V to +2.5 V
- 0 V to +40V
- 0 V to +20 V
- 0 V to +10 V
- 0 V to +5 V

图 47 shows a block diagram of the DAC architecture.

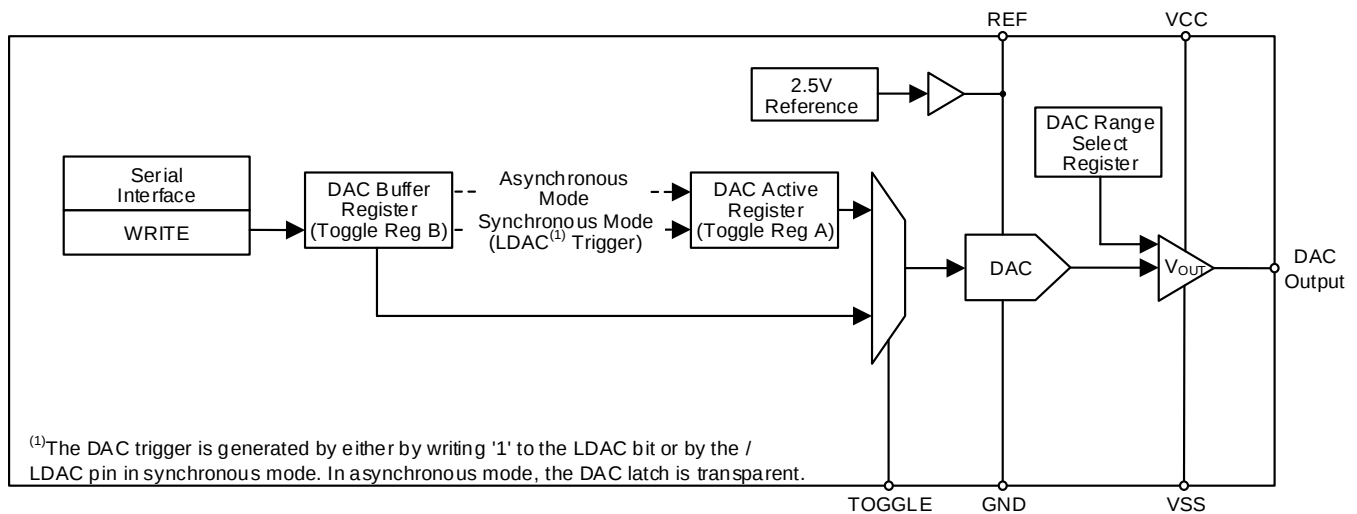


图 47. DACx1408 DAC Block Diagram

#### 9.3.1.1 DAC Transfer Function

The input data are written to the individual DAC Data registers in straight binary format for all output ranges. The DAC transfer function is given by 公式 1.

$$V_{OUT} = \left( \frac{CODE}{2^n} \times FSR \right) + V_{MIN} \quad (1)$$

where

- CODE is the decimal equivalent of the binary code that is loaded to the DAC register. CODE range is from 0 to  $2^n - 1$ .
- n is the DAC resolution in bits. Either 12 (DAC61408), 14 (DAC71408) or 16 (DAC81408).
- FSR is the DAC full-scale range. Equal to  $V_{MAX} - V_{MIN}$  for the selected DAC output range.
- $V_{MIN}$  is the lowest voltage for the selected DAC output range.

## Feature Description (接下页)

### 9.3.1.2 DAC Register Structure

Data written to the DAC data registers is initially stored in the DAC buffer registers. Transfer of data from the DAC buffer registers to the active DAC registers can be configured to happen immediately (asynchronous mode) or initiated by a DAC trigger signal (synchronous mode). Once the DAC active registers are updated, the DAC outputs change to the new values.

After a power-on or reset event, all DAC registers are set to zero code, the DAC output amplifiers are powered down, and the DAC outputs are clamped to ground.

#### 9.3.1.2.1 DAC Register Synchronous and Asynchronous Updates

The update mode for each DAC channel is determined by the status of its corresponding SYNC-EN bit. In asynchronous mode, a write to the DAC data register results in an immediate update of the DAC active register and DAC output on a  $\overline{CS}$  rising edge. In synchronous mode, writing to the DAC data register does not automatically update the DAC output. Instead the update occurs only after a trigger event. A DAC trigger signal is generated either through the LDAC bit or by the LDAC pin. The synchronous update mode enables simultaneous update of multiple DAC outputs. In both update modes a minimum wait time of 1  $\mu$ s is required between DAC output updates.

#### 9.3.1.2.2 Broadcast DAC Register

The DAC broadcast register enables a simultaneous update of multiple DAC outputs with the same value with a single register write. Broadcast operation is only possible when all DAC channels are in single-ended mode operation. If one or more outputs are configured in differential mode the broadcast command is ignored.

Each DAC channel can be configured to update or remain unaffected by a broadcast command by setting the corresponding DAC-BROADCAST-EN bit. A register write to the BROADCAST-DATA register forces those DAC channels that have been configured for broadcast operation to update their DAC buffer registers to this value. The DAC outputs update to the broadcast value according to their synchronous mode configuration.

#### 9.3.1.2.3 Clear DAC Operation

The DAC outputs are set in clear mode through the  $\overline{CLEAR}$  pin. In clear mode each DAC data channel is set to the clear code associated with its configuration as shown in . A  $\overline{CLR}$  pin logic low forces all DAC channels to clear the contents of their buffer and active registers to the clear code, and sets the analog outputs accordingly regardless of their synchronization setting.

**表 1. Clear DAC Value**

| UNIPOLAR / BIPOLAR RANGE | DIFFERENTIAL MODE | CLEAR CODE    |
|--------------------------|-------------------|---------------|
| Unipolar                 | No                | Zero code     |
| Unipolar                 | Yes               | Midscale code |
| Bipolar                  | No                | Midscale code |
| Bipolar                  | Yes               | Midscale code |

When a DAC is operating in toggle mode, a clear command sets both toggle registers to the clear value.

### 9.3.2 Internal Reference

The DAX1408 include a 2.5-V bandgap reference with a typical temperature drift of 5 ppm/°C. The internal reference is externally available at the REF pin. An external buffer amplifier with a high impedance input is required to drive any external load.

A minimum 150-nF capacitor is recommended between the reference output and GND for noise filtering. A compensation capacitor (330 pF, typical) should be connected between the REFCMP pin and REFGND.

Operation from an external reference is also supported by powering down the internal reference. The external reference is applied to the REF pin.

### 9.3.3 Device Reset Options

#### 9.3.3.1 Power-on-Reset (POR)

The DACx1408 includes a power-on reset function. After the supplies have been established, a POR event is issued. The POR causes all registers to initialize to their default values and communication with the device is valid only after a 1 ms power-on-reset delay. After a POR event, the device is set in power-down mode where all DAC channels and internal reference are powered down and the DAC output pins are connected to ground through a 10-kΩ internal resistor.

#### 9.3.3.2 Hardware Reset

A device hardware reset event is initiated by a minimum 500 ns logic low on the  $\overline{\text{RESET}}$  pin. A hardware reset initiates a POR event.

#### 9.3.3.3 Software Reset

A device software reset event is initiated by writing the reserved code 0x1010 to SOFT-RESET in the TRIGGER register. The software reset command is triggered on the  $\overline{\text{CS}}$  rising edge of the instruction. A software reset initiates a POR event.

### 9.3.4 Thermal Protection

Due to the DACx1408 DAC channel density and high drive capability it is important to understand the effects of power dissipation on the temperature of the device and ensure it does not exceed the maximum junction temperature.

#### 9.3.4.1 Analog Temperature Sensor: TEMPOUT Pin

The DACx1408 includes an analog temperature monitor with an unbuffered output voltage that is inversely proportional to the device junction temperature. The TEMPOUT pin output voltage has a temperature slope of -4 mV/°C and a 1.34-V offset as described by 公式 2.

$$V_{\text{TEMPOUT}} = \left( \frac{-4 \text{ mV}}{^{\circ}\text{C}} \times T \right) + 1.34 \text{ V} \quad (2)$$

where:

- T is the device junction temperature in °C.
- $V_{\text{TEMPOUT}}$  is the temperature monitor output voltage.

#### 9.3.4.2 Thermal Shutdown

The DACx1408 incorporates a thermal shutdown that is triggered when the die temperature exceeds 140°C. A thermal shutdown sets the TEMP-ALM bit and causes all DAC outputs to power-down, however the internal reference remains powered on. The ALMOUT pin can be configured to monitor a thermal shutdown condition by setting the TEMPALM-EN bit. Once a thermal shutdown is triggered, the device stays in shutdown even after the device temperature lowers.

The die temperature must fall below 140°C before the device can be returned to normal operation. To resume normal operation, the thermal alarm must be cleared through the ALM-RESET bit while the DAC channels are in power-down mode.

## 9.4 Device Functional Modes

### 9.4.1 Toggle Mode

Each DAC in the device can be independently configured to operate in toggle mode. A DAC channel in toggle mode incorporates two DAC registers (Register A and Register B) and can be set to switch repetitively between these two values. The DACx1408 toggle mode operation can be configured to introduce a dither signal to the DAC output, to generate a periodic signal or to implement ON/OFF signaling, among some examples.

To update the toggle registers the following sequence should be followed:

1. Set DAC channel in synchronous mode and disable toggle mode for that channel
2. Write the desired Register A value to the DAC data register
3. Issue a DAC trigger signal to load Register A
4. Write the desired Register B value to the DAC data register
5. Enable toggle mode to load Register B

Once both registers are loaded with data, any of the three TOGGLE[2:0] pins can be used to switch those DACs configured for toggle operation back and forth between the contents of their two DAC specific registers by using an external clock or logic signal. A TOGGLE pin logic low updates the DAC output to the value set by Register A. A logic high updates the DAC output to the value set by Register B. The three TOGGLE[2:0] pins give the DACx1408 the option to operate with up to three toggle rates.

Additionally, the device can be configured for software controlled toggle operation by setting the SOFTTOGGLE-EN bit. In this mode, any of the three AB-TOG[2:0] bits can be used as a toggle control signal. Setting the ABTOG bit to 1 enables Register B and clearing it to 0 enables Register A.

### 9.4.2 Differential Mode

Each pair of DAC channels in the device can be independently configured to operate as a differential output pair. The differential output of a DACx-y pair is updated by writing to the DACx channel. For proper operation, the two DAC pairs must be configured to the same output range prior to enabling differential mode. 图 48 and 图 49 show the ideal differential output voltages ( $V_{DIFF}$ ) and common mode voltages ( $V_{CM}$ ) for a DAC differential pair configured for  $\pm 20$ -V and 0 to 40-V operation, respectively.

Once configured as a differential output, the DACx-y pair can be set for toggle operation by updating the DACx toggle registers as described in [Toggle Mode](#).

Imbalances between the two differential signals result in common-mode and amplitude errors. The device incorporates an offset register that enables the user to introduce a voltage offset to the DACy channel of the DACx-y differential pair to compensate for a DC offset error between the two channels. The offset compensation gives a  $\pm 0.2\%$ FSR adjustment window. The differential DAC data register must be rewritten after an update to the offset register.

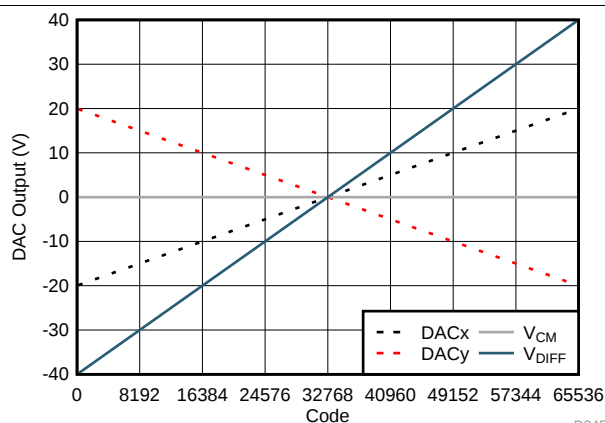


图 48. Differential Bipolar Output (16-Bit):  
 $\pm 20$ -V Output Range

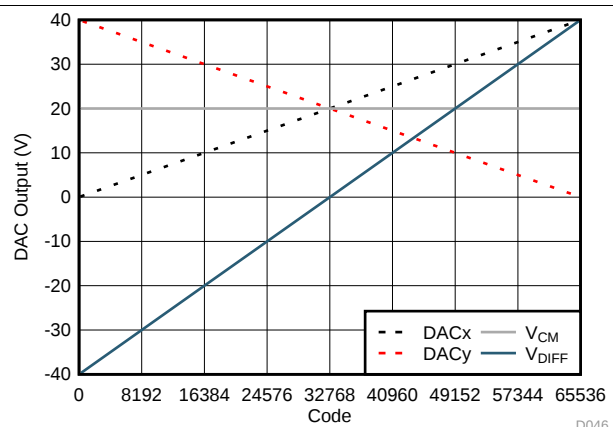


图 49. Differential Unipolar Output (16-Bit):  
0 to 40-V Output Range

## Device Functional Modes (接下页)

### 9.4.3 Power-Down Mode

The DACx1408 DAC output amplifiers and internal reference power-down status can be individually configured and monitored through the PWDWN registers. Setting a DAC channel in power-down mode disables the output amplifier and clamps the output pin to ground through an internal 10-kΩ resistor.

The DAC data registers are not cleared when the DAC goes into power-down which makes it possible to have the same output voltage upon return to normal operation. The DAC data registers can also be updated while in power-down mode.

After a power-on or reset event all the DAC channels and the internal reference are in power-down mode. The entire device can be configured into power-down or active modes through the DEV-PWDWN bit.

## 9.5 Programming

The DACx1408 is controlled through a flexible four-wire serial interface that is compatible with SPI type interfaces used on many microcontrollers and DSP controllers. The interface provides access to the DACx1408 registers and can be configured to daisy-chain multiple devices for write operations. The DACx1408 incorporates an optional error checking mode to validate SPI data communication integrity in noisy environments.

### 9.5.1 Stand-Alone Operation

A serial interface access cycle is initiated by asserting the  $\overline{\text{CS}}$  pin low. The serial clock SCLK can be a continuous or gated clock. SDI data are clocked on SCLK falling edges. A regular serial interface access cycle is 24 bits long with error checking disabled and 32 bits long with error checking enabled, thus the  $\overline{\text{CS}}$  pin must stay low for at least 24 or 32 SCLK falling edges. The access cycle ends when the  $\overline{\text{CS}}$  pin is de-asserted high. If the access cycle contains less than the minimum clock edges, the communication is ignored. If the access cycle contains more than the minimum clock edges, only the first 24 or 32 bits are used by the device. When  $\overline{\text{CS}}$  is high, the SCLK and SDI signals are blocked and the SDO is in a Hi-Z state.

In an error checking disabled access cycle (24 bits long) the first byte input to SDI is the instruction cycle which identifies the request as a read or write command and the 6-bit address to be accessed. The last 16 bits in the cycle form the data cycle.

**表 2. Serial Interface Access Cycle**

| BIT   | FIELD    | DESCRIPTION                                                                                                                                                                              |
|-------|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 23    | RW       | Identifies the communication as a read or write command to the address register. R/W = 0 sets a write operation. R/W = 1 sets a read operation.                                          |
| 22    | x        | Don't care bit.                                                                                                                                                                          |
| 21-16 | A[5:0]   | Register address. Specifies the register to be accessed during the read or write operation.                                                                                              |
| 15-0  | DI[15:0] | Data cycle bits. If a write command, the data cycle bits are the values to be written to the register with address A[5:0]. If a read command, the data cycle bits are don't care values. |

Read operations require that the SDO pin is first enabled by setting the SDO-EN bit. A read operation is initiated by issuing a read command access cycle. After the read command, a second access cycle must be issued to get the requested data. Data are clocked out on SDO pin either on the falling edge or rising edge of SCLK according to the FSDO bit.

**表 3. SDO Output Access Cycle**

| BIT   | FIELD    | DESCRIPTION                                       |
|-------|----------|---------------------------------------------------|
| 23    | RW       | Echo RW from previous access cycle.               |
| 22    | x        | Echo bit 22 from previous access cycle.           |
| 21-16 | A[5:0]   | Echo address from previous access cycle.          |
| 15-0  | DO[15:0] | Readback data requested on previous access cycle. |

### 9.5.1.1 Streaming Mode Operation

Since updating the eight channels data registers requires a large amount of data to be passed to the device, the device supports streaming mode. In streaming mode the DAC data registers can be written to the device without providing an instruction command for each data register. Streaming mode is enabled by setting the STREN bit. Once enabled the streaming operation is implemented by holding the  $\overline{CS}$  active and continuing to shift new data into the device.

The instruction cycle includes the starting address. The device starts writing to this address and automatically increments the address as long as  $\overline{CS}$  is asserted. If the last DAC data register address has been reached and  $\overline{CS}$  is still asserted, the additional data is ignored by the device.

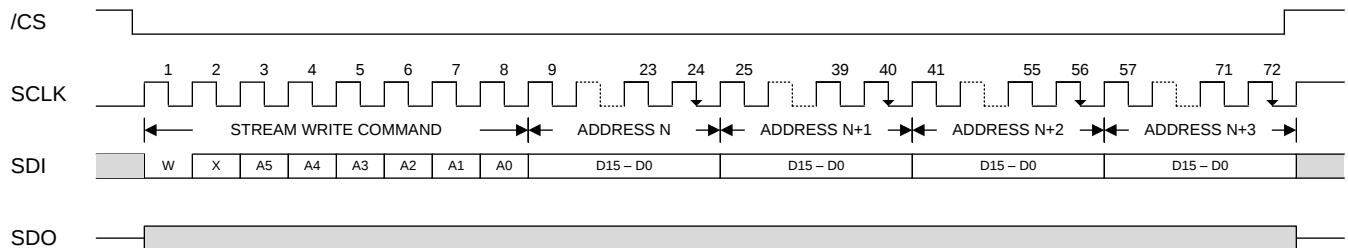


图 50. Serial Interface Streaming Write Cycle

### 9.5.2 Daisy-Chain Operation

For systems that contain more than one DACx1408 devices, the SDO pin can be used to daisy-chain them together. The SDO pin must be enabled by setting the SDO-EN bit before initiating the daisy-chain operation. Daisy-chain operation is useful in reducing the number of serial interface lines.

The first falling edge on the  $\overline{CS}$  pin starts the operation cycle. If more than 24 SCLK pulses are applied while the  $\overline{CS}$  pin is kept low, the data ripples out of the shift register and is clocked out on the SDO pin either on the falling edge or rising edge of SCLK according to the FSDO bit. By connecting the SDO output of the first device in the chain to the SDI input of the next device, a multiple-device interface is constructed. Each device in the system requires 24 clock pulses. As a result the total number of clock cycles must be equal to  $24 \times N$ , where N is the total number of DACx1408 devices in the daisy chain. When the serial transfer to all devices is complete the  $\overline{CS}$  signal is taken high. This action transfers the data from the SPI shift registers to the internal registers of each device in the daisy chain and prevents any further data from being clocked into the input shift register. Daisy-chain operation is not supported while in streaming mode.

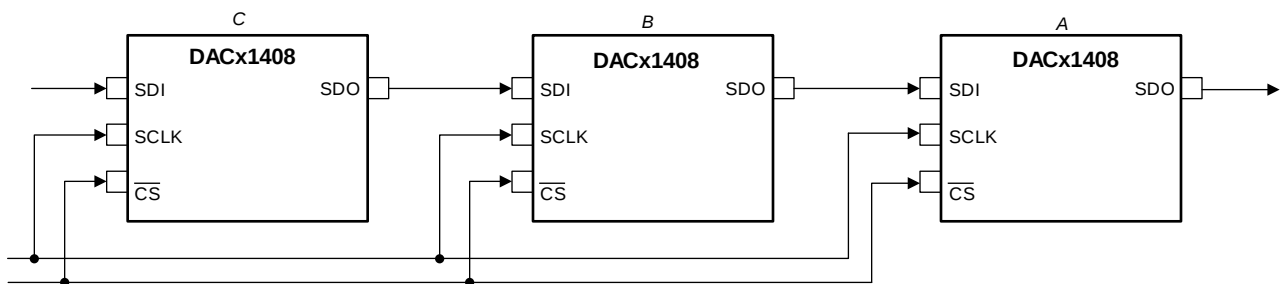


图 51. Daisy-Chain Layout

### 9.5.3 Frame Error Checking

If the DACx1408 is used in a noisy environment, error checking can be used to check the integrity of SPI data communication between the device and the host processor. This feature is enabled by setting the CRC-EN bit.

The error checking scheme is based on the CRC-8-ATM (HEC) polynomial  $x^8 + x^2 + x + 1$  (that is, 100000111). When error checking is enabled, the serial interface access cycle width is 32 bits. The normal 24-bit SPI data is appended with an 8-bit CRC polynomial by the host processor before feeding it to the device. In all serial interface readback operations the CRC polynomial is output on the SDO pin as part of the 32-bit cycle.

**表 4. Error Checking Serial Interface Access Cycle**

| BIT   | FIELD     | DESCRIPTION                                                                                                                                                                              |
|-------|-----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 31    | RW        | Identifies the communication as a read or write command to the address register. R/W = 0 sets a write operation. R/W = 1 sets a read operation.                                          |
| 30    | CRC-ERROR | Reserved bit. Set to zero.                                                                                                                                                               |
| 29-24 | A[5:0]    | Register address. Specifies the register to be accessed during the read or write operation.                                                                                              |
| 23-8  | DI[15:0]  | Data cycle bits. If a write command, the data cycle bits are the values to be written to the register with address A[5:0]. If a read command, the data cycle bits are don't care values. |
| 7-0   | CRC       | 8-bit CRC polynomial.                                                                                                                                                                    |

The DACx1408 decodes the 32-bit access cycle to compute the CRC remainder on CS rising edges. If no error exists, the CRC remainder is zero and data are accepted by the device.

A write operation failing the CRC check causes the data to be ignored by the device. After the write command, a second access cycle can be issued to determine the error checking results (CRC-ERROR bit) on the SDO pin.

If there is a CRC error, the CRC-ALM bit of the status register is set to 1. The  $\overline{\text{ALMOUT}}$  pin can be configured to monitor a CRC error by setting the CRCALM-EN bit.

**表 5. Write Operation Error Checking Cycle**

| BIT   | FIELD     | DESCRIPTION                                            |
|-------|-----------|--------------------------------------------------------|
| 31    | RW        | Echo RW from previous access cycle (RW = 0).           |
| 30    | CRC-ERROR | Returns a 1 when a CRC error is detected, 0 otherwise. |
| 29-24 | A[5:0]    | Echo address from previous access cycle.               |
| 23-8  | DO[15:0]  | Echo data from previous access cycle.                  |
| 7-0   | CRC       | Calculated CRC value of bits 31:8.                     |

A read operation must be followed by a second access cycle to get the requested data on the SDO pin. The error check result (CRC-ERROR bit) from the read command is output on the SDO pin.

As in the case of a write operation failing the CRC check, the CRC-ALM bit of the status register is set to 1 and the  $\overline{\text{ALMOUT}}$  pin, if configured for CRC alerts, is set low.

**表 6. Read Operation Error Checking Cycle**

| BIT   | FIELD     | DESCRIPTION                                            |
|-------|-----------|--------------------------------------------------------|
| 31    | RW        | Echo RW from previous access cycle (RW = 1).           |
| 30    | CRC-ERROR | Returns a 1 when a CRC error is detected, 0 otherwise. |
| 29-24 | A[5:0]    | Echo address from previous access cycle.               |
| 23-8  | DO[15:0]  | Echo data from previous access cycle.                  |
| 7-0   | CRC       | Calculated CRC value of bits 31:8.                     |

## 9.6 Register Maps

表 7 lists the memory-mapped registers for the device. All register offset addresses not listed in 表 7 should be considered as reserved locations and the register contents should not be modified.

**表 7. DACx1408 Registers**

| Offset | Acronym     | Register Name                             | Section            |
|--------|-------------|-------------------------------------------|--------------------|
| 00h    | NOP         | NOP Register                              | <a href="#">Go</a> |
| 01h    | DEVICEID    | Device ID Register                        | <a href="#">Go</a> |
| 02h    | STATUS      | Status Register                           | <a href="#">Go</a> |
| 03h    | SPICONFIG   | SPI Configuration Register                | <a href="#">Go</a> |
| 04h    | GENCONFIG   | General Configuration Register            | <a href="#">Go</a> |
| 05h    | BRDCONFIG   | Broadcast Configuration Register          | <a href="#">Go</a> |
| 06h    | SYNCCONFIG  | Sync Configuration Register               | <a href="#">Go</a> |
| 07h    | TOGGCONFIG0 | DAC[7:4] Toggle Configuration Register    | <a href="#">Go</a> |
| 08h    | TOGGCONFIG1 | DAC[3:0] Toggle Configuration Register    | <a href="#">Go</a> |
| 09h    | DACPWDWN    | DAC Power-Down Register                   | <a href="#">Go</a> |
| 0Bh    | DACRANGE0   | DAC[7:4] Range Register                   | <a href="#">Go</a> |
| 0Ch    | DACRANGE1   | DAC[3:0] Range Register                   | <a href="#">Go</a> |
| 0Eh    | TRIGGER     | Trigger Register                          | <a href="#">Go</a> |
| 0Fh    | BRDCAST     | Broadcast Data Register                   | <a href="#">Go</a> |
| 14h    | DAC0        | DAC0 Data Register                        | <a href="#">Go</a> |
| 15h    | DAC1        | DAC1 Data Register                        | <a href="#">Go</a> |
| 16h    | DAC2        | DAC2 Data Register                        | <a href="#">Go</a> |
| 17h    | DAC3        | DAC3 Data Register                        | <a href="#">Go</a> |
| 18h    | DAC4        | DAC4 Data Register                        | <a href="#">Go</a> |
| 19h    | DAC5        | DAC5 Data Register                        | <a href="#">Go</a> |
| 1Ah    | DAC6        | DAC6 Data Register                        | <a href="#">Go</a> |
| 1Bh    | DAC7        | DAC7 Data Register                        | <a href="#">Go</a> |
| 21h    | OFFSET0     | DAC[6-7;4-5] Differential Offset Register | <a href="#">Go</a> |
| 22h    | OFFSET1     | DAC[2-3;0-1] Differential Offset Register | <a href="#">Go</a> |

Complex bit access types are encoded to fit into small table cells. 表 8 shows the codes that are used for access types in this section.

**表 8. Access Type Codes**

| Access Type                     | Code | Description                                                                                                                                                                                                                                                                          |
|---------------------------------|------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <b>Read Type</b>                |      |                                                                                                                                                                                                                                                                                      |
| R                               | R    | Read                                                                                                                                                                                                                                                                                 |
| <b>Write Type</b>               |      |                                                                                                                                                                                                                                                                                      |
| W                               | W    | Write                                                                                                                                                                                                                                                                                |
| <b>Reset or Default Value</b>   |      |                                                                                                                                                                                                                                                                                      |
| -n                              |      | Value after reset or the default value                                                                                                                                                                                                                                               |
| <b>Register Array Variables</b> |      |                                                                                                                                                                                                                                                                                      |
| i,j,k,l,m,n                     |      | When these variables are used in a register name, an offset, or an address, they refer to the value of a register array where the register is part of a group of repeating registers. The register groups form a hierarchical structure and the array is represented with a formula. |
| y                               |      | When this variable is used in a register name, an offset, or an address it refers to the value of a register array.                                                                                                                                                                  |

### 9.6.1 NOP Register (Offset = 00h) [reset = 0000h]

NOP is shown in 图 52 and described in 表 9.

Return to [Summary Table](#).

**图 52. NOP Register**

|      |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
|------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| 15   | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| NOP  |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| W-0h |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**表 9. NOP Register Field Descriptions**

| Bit  | Field | Type | Reset | Description                                                |
|------|-------|------|-------|------------------------------------------------------------|
| 15-0 | NOP   | W    | 0h    | No operation. Write 0000h for proper no-operation command. |

### 9.6.2 DEVICEID Register (Offset = 01h) [reset = ----h]

DEVICEID is shown in 图 53 and described in 表 10.

Return to [Summary Table](#).

**图 53. DEVICEID Register**

|          |    |    |    |    |    |           |   |
|----------|----|----|----|----|----|-----------|---|
| 15       | 14 | 13 | 12 | 11 | 10 | 9         | 8 |
| DEVICEID |    |    |    |    |    |           |   |
| R----h   |    |    |    |    |    |           |   |
| 7        | 6  | 5  | 4  | 3  | 2  | 1         | 0 |
| DEVICEID |    |    |    |    |    | VERSIONID |   |
| R----h   |    |    |    |    |    | R-0h      |   |

**表 10. DEVICEID Register Field Descriptions**

| Bit  | Field     | Type | Reset | Description                                                     |
|------|-----------|------|-------|-----------------------------------------------------------------|
| 15-2 | DEVICEID  | R    | ---h  | Device ID<br>DAC81408: 298h<br>DAC71408: 288h<br>DAC61408: 248h |
| 1-0  | VERSIONID | R    | 0h    | Version ID. Subject to change.                                  |

### 9.6.3 STATUS Register (Offset = 02h) [reset = 0000h]

STATUS is shown in 图 54 and described in 表 11.

Return to [Summary Table](#).

**图 54. STATUS Register**

|          |    |    |    |         |    |          |          |
|----------|----|----|----|---------|----|----------|----------|
| 15       | 14 | 13 | 12 | 11      | 10 | 9        | 8        |
| RESERVED |    |    |    |         |    |          |          |
| R-0h     |    |    |    |         |    |          |          |
| 7        | 6  | 5  | 4  | 3       | 2  | 1        | 0        |
| RESERVED |    |    |    | CRC-ALM |    | DAC-BUSY | TEMP-ALM |
| R-0h     |    |    |    | R-0h    |    | R-0h     | R-0h     |

**表 11. STATUS Register Field Descriptions**

| Bit  | Field    | Type | Reset | Description                                                                                                                     |
|------|----------|------|-------|---------------------------------------------------------------------------------------------------------------------------------|
| 15-3 | RESERVED | R    | 0h    | This bit is reserved.                                                                                                           |
| 2    | CRC-ALM  | R    | 0h    | CRC-ALM = 1 indicates a CRC error.                                                                                              |
| 1    | DAC-BUSY | R    | 0h    | DAC-BUSY = 1 indicates DAC registers are not ready for updates.                                                                 |
| 0    | TEMP-ALM | R    | 0h    | TEMP-ALM = 1 indicates die temperature is over +140°C. A thermal alarm event forces the DAC outputs to go into power-down mode. |

#### 9.6.4 SPICONFIG Register (Offset = 03h) [reset = 0A24h]

SPICONFIG is shown in 图 55 and described in 表 12.

Return to [Summary Table](#).

**图 55. SPICONFIG Register**

|          |               |           |        |            |            |           |          |
|----------|---------------|-----------|--------|------------|------------|-----------|----------|
| 15       | 14            | 13        | 12     | 11         | 10         | 9         | 8        |
| RESERVED |               |           |        | TEMPALM-EN | DACBUSY-EN | CRCALM-EN | RESERVED |
| R-0h     |               |           |        | R/W-1h     | R/W-0h     | R/W-1h    | R-0h     |
| 7        | 6             | 5         | 4      | 3          | 2          | 1         | 0        |
| RESERVED | SOFTTOGGLE-EN | DEV-PWDWN | CRC-EN | STR-EN     | SDO-EN     | FSDO      | RESERVED |
| R-1h     | R/W-0h        | R/W-1h    | R/W-0h | R/W-0h     | R/W-1h     | R/W-0h    | R-0h     |

**表 12. SPICONFIG Register Field Descriptions**

| Bit   | Field         | Type | Reset | Description                                                                                                                                          |
|-------|---------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-12 | RESERVED      | R    | 0h    | This bit is reserved.                                                                                                                                |
| 11    | TEMPALM-EN    | R/W  | 1h    | When set to 1 a thermal alarm triggers the $\overline{\text{ALMOUT}}$ pin.                                                                           |
| 10    | DACBUSY-EN    | R/W  | 0h    | When set to 1 the $\overline{\text{ALMOUT}}$ pin is set between DAC output updates. Contrary to other alarm events, this alarm resets automatically. |
| 9     | CRCALM-EN     | R/W  | 1h    | When set to 1 a CRC error triggers the $\overline{\text{ALMOUT}}$ pin.                                                                               |
| 8     | RESERVED      | R    | 0h    | This bit is reserved.                                                                                                                                |
| 7     | RESERVED      | R    | 1h    | This bit is reserved.                                                                                                                                |
| 6     | SOFTTOGGLE-EN | R/W  | 0h    | When set to 1 enables soft toggle operation.                                                                                                         |
| 5     | DEV-PWDWN     | R/W  | 1h    | DEV-PWDWN = 1 sets the device in power-down mode<br>DEV-PWDWN = 0 sets the device in active mode                                                     |
| 4     | CRC-EN        | R/W  | 0h    | When set to 1 frame error checking is enabled.                                                                                                       |
| 3     | STR-EN        | R/W  | 0h    | When set to 1 streaming mode operation is enabled.                                                                                                   |
| 2     | SDO-EN        | R/W  | 1h    | When set to 1 the SDO pin is operational.                                                                                                            |
| 1     | FSDO          | R/W  | 0h    | Fast SDO bit (half-cycle speedup). When 0, SDO updates during SCLK rising edges. When 1, SDO updates during SCLK falling edges.                      |
| 0     | RESERVED      | R    | 0h    | This bit is reserved.                                                                                                                                |

### 9.6.5 GENCONFIG Register (Offset = 04h) [reset = 7F00h]

GENCONFIG is shown in 图 56 and described in 表 13.

Return to [Summary Table](#).

**图 56. GENCONFIG Register**

| 15       | 14        | 13              | 12              | 11              | 10              | 9        | 8        |
|----------|-----------|-----------------|-----------------|-----------------|-----------------|----------|----------|
| RESERVED | REF-PWDWN | RESERVED        |                 |                 |                 |          |          |
| R-0h     | R/W-1h    | R-1h            |                 |                 |                 |          |          |
| 7        | 6         | 5               | 4               | 3               | 2               | 1        | 0        |
| RESERVED | RESERVED  | DAC-6-7-DIFF-EN | DAC-4-5-DIFF-EN | DAC-2-3-DIFF-EN | DAC-0-1-DIFF-EN | RESERVED | RESERVED |
| R-0h     | R-0h      | R/W-0h          | R/W-0h          | R/W-0h          | R/W-0h          | R-0h     | R-0h     |

**表 13. GENCONFIG Register Field Descriptions**

| Bit  | Field           | Type | Reset | Description                                                                                                                                                                   |
|------|-----------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15   | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                         |
| 14   | REF-PWDWN       | R/W  | 1h    | REF-PWDWN = 1 powers down the internal reference<br>REF-PWDWN = 0 activates the internal reference                                                                            |
| 13-8 | RESERVED        | R    | 1h    | This bit is reserved.                                                                                                                                                         |
| 7    | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                         |
| 6    | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                         |
| 5    | DAC-6-7-DIFF-EN | R/W  | 0h    | When set to 1 the corresponding DAC pair is set to operate in differential mode. The DAC data registers must be rewritten after enabling or disabling differential operation. |
| 4    | DAC-4-5-DIFF-EN | R/W  | 0h    |                                                                                                                                                                               |
| 3    | DAC-2-3-DIFF-EN | R/W  | 0h    |                                                                                                                                                                               |
| 2    | DAC-0-1-DIFF-EN | R/W  | 0h    |                                                                                                                                                                               |
| 1    | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                         |
| 0    | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                         |

### 9.6.6 BRDCONFIG Register (Offset = 05h) [reset = FFFFh]

BRDCONFIG is shown in 图 57 and described in 表 14.

Return to [Summary Table](#).

**图 57. BRDCONFIG Register**

|                   |                   |                   |                   |                   |                   |                   |                   |
|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|
| 15                | 14                | 13                | 12                | 11                | 10                | 9                 | 8                 |
| RESERVED          | RESERVED          | RESERVED          | RESERVED          | DAC7-BROADCAST-EN | DAC6-BROADCAST-EN | DAC5-BROADCAST-EN | DAC4-BROADCAST-EN |
| R-1h              | R-1h              | R-1h              | R-1h              | R/W-1h            | R/W-1h            | R/W-1h            | R/W-1h            |
| 7                 | 6                 | 5                 | 4                 | 3                 | 2                 | 1                 | 0                 |
| DAC3-BROADCAST-EN | DAC2-BROADCAST-EN | DAC1-BROADCAST-EN | DAC0-BROADCAST-EN | RESERVED          | RESERVED          | RESERVED          | RESERVED          |
| R/W-1h            | R/W-0h            | R/W-0h            | R/W-0h            | R-1h              | R-1h              | R-1h              | R-1h              |

**表 14. BRDCONFIG Register Field Descriptions**

| Bit | Field             | Type | Reset | Description                                                                                                                                                                                                                                                                           |
|-----|-------------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15  | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 14  | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 13  | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 12  | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 11  | DAC7-BROADCAST-EN | R/W  | 1h    | When set to 1 the corresponding DAC is set to update its output to the value set in the BRDCAST register. All DAC channels must be configured in single-ended mode for broadcast operation. If one or more outputs are configured in differential mode the broadcast mode is ignored. |
| 10  | DAC6-BROADCAST-EN | R/W  | 1h    |                                                                                                                                                                                                                                                                                       |
| 9   | DAC5-BROADCAST-EN | R/W  | 1h    |                                                                                                                                                                                                                                                                                       |
| 8   | DAC4-BROADCAST-EN | R/W  | 1h    |                                                                                                                                                                                                                                                                                       |
| 7   | DAC3-BROADCAST-EN | R/W  | 1h    |                                                                                                                                                                                                                                                                                       |
| 6   | DAC2-BROADCAST-EN | R/W  | 1h    |                                                                                                                                                                                                                                                                                       |
| 5   | DAC1-BROADCAST-EN | R/W  | 1h    |                                                                                                                                                                                                                                                                                       |
| 4   | DAC0-BROADCAST-EN | R/W  | 1h    | When cleared to 0 the corresponding DAC output remains unaffected by a BRDCAST command.                                                                                                                                                                                               |
| 3   | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 2   | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 1   | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |
| 0   | RESERVED          | R    | 1h    | This bit is reserved.                                                                                                                                                                                                                                                                 |

### 9.6.7 SYNCCONFIG Register (Offset = 06h) [reset = 0000h]

SYNCCONFIG is shown in 图 58 and described in 表 15.

Return to [Summary Table](#).

**图 58. SYNCCONFIG Register**

| 15           | 14           | 13           | 12           | 11           | 10           | 9            | 8            |
|--------------|--------------|--------------|--------------|--------------|--------------|--------------|--------------|
| RESERVED     | RESERVED     | RESERVED     | RESERVED     | DAC7-SYNC-EN | DAC6-SYNC-EN | DAC5-SYNC-EN | DAC4-SYNC-EN |
| R-0h         | R-0h         | R-0h         | R-0h         | R/W-0h       | R/W-0h       | R/W-0h       | R/W-0h       |
| 7            | 6            | 5            | 4            | 3            | 2            | 1            | 0            |
| DAC3-SYNC-EN | DAC2-SYNC-EN | DAC1-SYNC-EN | DAC0-SYNC-EN | RESERVED     | RESERVED     | RESERVED     | RESERVED     |
| R/W-0h       | R/W-0h       | R/W-0h       | R/W-0h       | R-0h         | R-0h         | R-0h         | R-0h         |

**表 15. SYNCCONFIG Register Field Descriptions**

| Bit | Field        | Type | Reset | Description                                                                                                                                                                                                        |
|-----|--------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15  | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 14  | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 13  | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 12  | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 11  | DAC7-SYNC-EN | R/W  | 0h    | When set to 1 the corresponding DAC output is set to update in response to an LDAC trigger (synchronous mode).<br>When cleared to 0 the corresponding DAC output is set to update immediately (asynchronous mode). |
| 10  | DAC6-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 9   | DAC5-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 8   | DAC4-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 7   | DAC3-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 6   | DAC2-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 5   | DAC1-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 4   | DAC0-SYNC-EN | R/W  | 0h    |                                                                                                                                                                                                                    |
| 3   | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 2   | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 1   | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |
| 0   | RESERVED     | R    | 0h    | This bit is reserved.                                                                                                                                                                                              |

### 9.6.8 TOGGCONFIG0 Register (Offset = 07h) [reset = 0000h]

TOGGCONFIG0 is shown in 图 59 and described in 表 16.

Return to [Summary Table](#).

**图 59. TOGGCONFIG0 Register**

|                 |    |                 |    |                 |    |                 |   |
|-----------------|----|-----------------|----|-----------------|----|-----------------|---|
| 15              | 14 | 13              | 12 | 11              | 10 | 9               | 8 |
| RESERVED        |    | RESERVED        |    | RESERVED        |    | RESERVED        |   |
| R-0h            |    | R-0h            |    | R-0h            |    | R-0h            |   |
| 7               | 6  | 5               | 4  | 3               | 2  | 1               | 0 |
| DAC7-AB-TOGG-EN |    | DAC6-AB-TOGG-EN |    | DAC5-AB-TOGG-EN |    | DAC4-AB-TOGG-EN |   |
| R/W-0h          |    | R/W-0h          |    | R/W-0h          |    | R/W-0h          |   |

**表 16. TOGGCONFIG0 Register Field Descriptions**

| Bit   | Field           | Type | Reset | Description                                                                                                                                                                                                                 |
|-------|-----------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-14 | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 13-12 | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 11-10 | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 9-8   | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 7-6   | DAC7-AB-TOGG-EN | R/W  | 0h    | Enables toggle mode operation and configures the toggle pin or soft toggle bit:<br>0h = Toggle mode disabled<br>1h = Toggle mode enabled: TOGGLE0<br>2h = Toggle mode enabled: TOGGLE1<br>3h = Toggle mode enabled: TOGGLE2 |
| 5-4   | DAC6-AB-TOGG-EN | R/W  | 0h    |                                                                                                                                                                                                                             |
| 3-2   | DAC5-AB-TOGG-EN | R/W  | 0h    |                                                                                                                                                                                                                             |
| 1-0   | DAC4-AB-TOGG-EN | R/W  | 0h    |                                                                                                                                                                                                                             |

### 9.6.9 TOGGCONFIG1 Register (Offset = 08h) [reset = 0000h]

TOGGCONFIG1 is shown in 图 60 and described in 表 17.

Return to [Summary Table](#).

**图 60. TOGGCONFIG1 Register**

|                 |    |                 |    |                 |    |                 |   |
|-----------------|----|-----------------|----|-----------------|----|-----------------|---|
| 15              | 14 | 13              | 12 | 11              | 10 | 9               | 8 |
| DAC3-AB-TOGG-EN |    | DAC2-AB-TOGG-EN |    | DAC1-AB-TOGG-EN |    | DAC0-AB-TOGG-EN |   |
| R/W-0h          |    | R/W-0h          |    | R/W-0h          |    | R/W-0h          |   |
| 7               | 6  | 5               | 4  | 3               | 2  | 1               | 0 |
| RESERVED        |    | RESERVED        |    | RESERVED        |    | RESERVED        |   |
| R-0h            |    | R-0h            |    | R-0h            |    | R-0h            |   |

**表 17. TOGGCONFIG1 Register Field Descriptions**

| Bit   | Field           | Type | Reset | Description                                                                                                                                                                                                                 |
|-------|-----------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-14 | DAC3-AB-TOGG-EN | R/W  | 0h    | Enables toggle mode operation and configures the toggle pin or soft toggle bit:<br>0h = Toggle mode disabled<br>1h = Toggle mode enabled: TOGGLE0<br>2h = Toggle mode enabled: TOGGLE1<br>3h = Toggle mode enabled: TOGGLE2 |
| 13-12 | DAC2-AB-TOGG-EN | R/W  | 0h    |                                                                                                                                                                                                                             |
| 11-10 | DAC1-AB-TOGG-EN | R/W  | 0h    |                                                                                                                                                                                                                             |
| 9-8   | DAC0-AB-TOGG-EN | R/W  | 0h    |                                                                                                                                                                                                                             |
| 7-6   | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 5-4   | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 3-2   | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |
| 1-0   | RESERVED        | R    | 0h    | This bit is reserved.                                                                                                                                                                                                       |

### 9.6.10 DACPWDWN Register (Offset = 09h) [reset = FFFFh]

DACPWDWN is shown in 图 61 and described in 表 18.

Return to [Summary Table](#).

**图 61. DACPWDWN Register**

| 15         | 14         | 13         | 12         | 11         | 10         | 9          | 8          |
|------------|------------|------------|------------|------------|------------|------------|------------|
| RESERVED   | RESERVED   | RESERVED   | RESERVED   | DAC7-PWDWN | DAC6-PWDWN | DAC5-PWDWN | DAC4-PWDWN |
| R-1h       | R-1h       | R-1h       | R-1h       | R/W-1h     | R/W-1h     | R/W-1h     | R/W-1h     |
| 7          | 6          | 5          | 4          | 3          | 2          | 1          | 0          |
| DAC3-PWDWN | DAC2-PWDWN | DAC1-PWDWN | DAC0-PWDWN | RESERVED   | RESERVED   | RESERVED   | RESERVED   |
| R/W-1h     | R/W-1h     | R/W-1h     | R/W-1h     | R-1h       | R-1h       | R-1h       | R-1h       |

**表 18. DACPWDWN Register Field Descriptions**

| Bit | Field      | Type | Reset | Description                                                                                                                     |
|-----|------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------|
| 15  | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 14  | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 13  | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 12  | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 11  | DAC7-PWDWN | R/W  | 1h    | When set to 1 the corresponding DAC is in power-down mode and its output is connected to GND through a 10-kΩ internal resistor. |
| 10  | DAC6-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 9   | DAC5-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 8   | DAC4-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 7   | DAC3-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 6   | DAC2-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 5   | DAC1-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 4   | DAC0-PWDWN | R/W  | 1h    |                                                                                                                                 |
| 3   | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 2   | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 1   | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |
| 0   | RESERVED   | R    | 1h    | This bit is reserved.                                                                                                           |

### 9.6.11 DACRANGEn Register (Offset = 0Bh - 0Ch) [reset = 0000h]

DACRANGEn is shown in 图 62 and described in 表 19.

Return to [Summary Table](#).

**图 62. DACRANGEn Register**

|                 |    |    |    |                 |    |   |   |
|-----------------|----|----|----|-----------------|----|---|---|
| 15              | 14 | 13 | 12 | 11              | 10 | 9 | 8 |
| DACa-RANGE[3:0] |    |    |    | DACb-RANGE[3:0] |    |   |   |
| W-0h            |    |    |    | W-0h            |    |   |   |
| 7               | 6  | 5  | 4  | 3               | 2  | 1 | 0 |
| DACc-RANGE[3:0] |    |    |    | DACd-RANGE[3:0] |    |   |   |
| W-0h            |    |    |    | W-0h            |    |   |   |

**表 19. DACRANGEn Register Field Descriptions**

| Bit   | Field           | Type | Reset | Description                                                                                                                                                                                                                                                |
|-------|-----------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-12 | DACa-RANGE[3:0] | W    | 0h    | Sets the output range for the corresponding DAC.<br>0000 = 0 to 5 V<br>0001 = 0 to 10 V<br>0010 = 0 to 20 V<br>0100 = 0 to 40 V<br>1001 = -5 V to +5 V<br>1010 = -10 V to +10 V<br>1100 = -20 V to +20 V<br>1110 = -2.5 V to +2.5 V<br>All others: invalid |
| 11-8  | DACb-RANGE[3:0] | W    | 0h    |                                                                                                                                                                                                                                                            |
| 7-4   | DACc-RANGE[3:0] | W    | 0h    |                                                                                                                                                                                                                                                            |
| 3-0   | DACd-RANGE[3:0] | W    | 0h    | The two outputs of a differential DAC pair must be configured to the same output range prior to setting them up as a differential pair.<br>a: 7 or 3; b: 6 or 2; c: 5 or 1; d: 4 or 0                                                                      |

### 9.6.12 TRIGGER Register (Offset = 0Eh) [reset = 0000h]

TRIGGER is shown in 图 63 and described in 表 20.

Return to [Summary Table](#).

**图 63. TRIGGER Register**

|          |         |         |      |                 |    |   |           |
|----------|---------|---------|------|-----------------|----|---|-----------|
| 15       | 14      | 13      | 12   | 11              | 10 | 9 | 8         |
| RESERVED |         |         |      |                 |    |   | ALM-RESET |
| W-0h     |         |         |      |                 |    |   | W-0h      |
| 7        | 6       | 5       | 4    | 3               | 2  | 1 | 0         |
| AB-TOG2  | AB-TOG1 | AB-TOG0 | LDAC | SOFT-RESET[3:0] |    |   |           |
| W-0h     | W-0h    | W-0h    | W-0h | W-0h            |    |   |           |

**表 20. TRIGGER Register Field Descriptions**

| Bit  | Field           | Type | Reset | Description                                                                                                                                                                                                                |
|------|-----------------|------|-------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-9 | RESERVED        | W    | 0h    | This bit is reserved                                                                                                                                                                                                       |
| 8    | ALM-RESET       | W    | 0h    | Set this bit to 1 to clear an alarm event. Not applicable for a DAC-BUSY alarm event.                                                                                                                                      |
| 7    | AB-TOG2         | W    | 0h    | If soft toggle is enabled set, this bit controls the toggle between values for those DACs that have been set in toggle mode 2 in the TOGGCONFIG register. Set to 1 to update to Register B and clear to 0 for Register A.  |
| 6    | AB-TOG1         | W    | 0h    | If soft toggle is enabled set, this bit controls the toggle between values for those DACs that have been set in toggle mode 1 in the TOGGCONFIG register. Set to 1 to updated to Register B and clear to 0 for Register A. |
| 5    | AB-TOG0         | W    | 0h    | If soft toggle is enabled set, this bit controls the toggle between values for those DACs that have been set in toggle mode 0 in the TOGGCONFIG register. Set to 1 to update to Register B and clear to 0 for Register A.  |
| 4    | LDAC            | W    | 0h    | Set this bit to 1 to synchronously load those DACs who have been set in synchronous mode in the SYNCCONFIG register.                                                                                                       |
| 3-0  | SOFT-RESET[3:0] | W    | 0h    | When set to the reserved code 1010 resets the device to its default state.                                                                                                                                                 |

### 9.6.13 BRDCAST Register (Offset = 0Fh) [reset = 0000h]

BRDCAST is shown in 图 64 and described in 表 21.

Return to [Summary Table](#).

**图 64. BRDCAST Register**

|                    |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
|--------------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| 15                 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| BRDCAST-DATA[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| R/W-0h             |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**表 21. BRDCAST Register Field Descriptions**

| Bit  | Field              | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                            |
|------|--------------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-0 | BRDCAST-DATA[15:0] | R/W  | 0h    | <p>Writing to the BRDCAST register forces those DAC channels that have been set to broadcast in the BRDCONFIG register to update its active register data to the BRDCAST-DATA one.</p> <p>Data is MSB aligned in straight binary format and follows the format below:</p> <p>DAC81408: { DATA[15:0] }</p> <p>DAC71408: { DATA[13:0], x, x }</p> <p>DAC61408: { DATA[11:0], x, x, x, x }</p> <p>x – Don't care bits</p> |

### 9.6.14 DACn Register (Offset = 14h - 1Bh) [reset = 0000h]

DACn is shown in 图 65 and described in 表 22.

Return to [Summary Table](#).

**图 65. DACn Register**

|                 |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
|-----------------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| DACn-DATA[15:0] |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |
| R/W-0h          |    |    |    |    |    |   |   |   |   |   |   |   |   |   |   |

**表 22. DACn Register Field Descriptions**

| Bit  | Field           | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|------|-----------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-0 | DACn-DATA[15:0] | R/W  | 0h    | <p>Stores the 16-, 14- or 12-bit data to be loaded to DACn in MSB aligned straight binary format. In differential DAC mode data is loaded into the lowest-valued DAC in the DAC pair (in pair DAC 01, data is loaded into DAC0 and writes to DAC1 are ignored).</p> <p>Data follows the format below:</p> <p>DAC81408: { DATA[15:0] }</p> <p>DAC71408: { DATA[13:0], x, x }</p> <p>DAC61408: { DATA[11:0], x, x, x, x }</p> <p>x – Don't care bits</p> |

### 9.6.15 OFFSETn Register (Offset = 21h - 22h) [reset = 0000h]

OFFSETn is shown in 图 66 and described in 表 23.

Return to [Summary Table](#).

**图 66. OFFSETn Register**

|               |    |    |    |    |    |   |   |
|---------------|----|----|----|----|----|---|---|
| 15            | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OFFSETab[7:0] |    |    |    |    |    |   |   |
| R/W-0h        |    |    |    |    |    |   |   |
| 7             | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OFFSETcd[7:0] |    |    |    |    |    |   |   |
| R/W-0h        |    |    |    |    |    |   |   |

**表 23. OFFSETn Register Field Descriptions**

| Bit  | Field         | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
|------|---------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15-8 | OFFSETab[7:0] | R/W  | 0h    | Provides offset adjustment to DACy in the differential DACx-y pair in two 's complement format.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| 7-0  | OFFSETcd[7:0] | R/W  | 0h    | <p>Data follows the format below:</p> <ul style="list-style-type: none"> <li>• DAC81408: <ul style="list-style-type: none"> <li>– Format: { OFFSET[7:0] }</li> <li>– Range: -128 LSB to +127 LSB</li> </ul> </li> <li>• DAC71408: <ul style="list-style-type: none"> <li>– Format: { OFFSET[5:0], x, x }</li> <li>– Range: -32 LSB to +31 LSB</li> </ul> </li> <li>• DAC61408: <ul style="list-style-type: none"> <li>– Format: { OFFSET[3:0], x, x, x, x }</li> <li>– Range: -8 LSB to +7 LSB</li> </ul> </li> </ul> <p>x – Don 't care bits</p> <p>The differential DAC data register must be rewritten after updating the offset register.</p> <p>ab: 6-7 or 2-3; cd: 4-5 or 0-1</p> |

## 10 Application and Implementation

### 注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 10.1 Application Information

The DACx1408 family provides 8-channel high-voltage and high-current output in both single-ended and differential configurations. The outputs can be configured to multiple ranges and square waves can be generated using the toggle modes. This makes the DAC family suitable for Automatic Test Equipment (ATE) and servo control applications. In addition to these features, the low power-on glitch of this DAC makes it suitable for Motor Control applications like CNC machines as well.

### 10.2 Typical Application

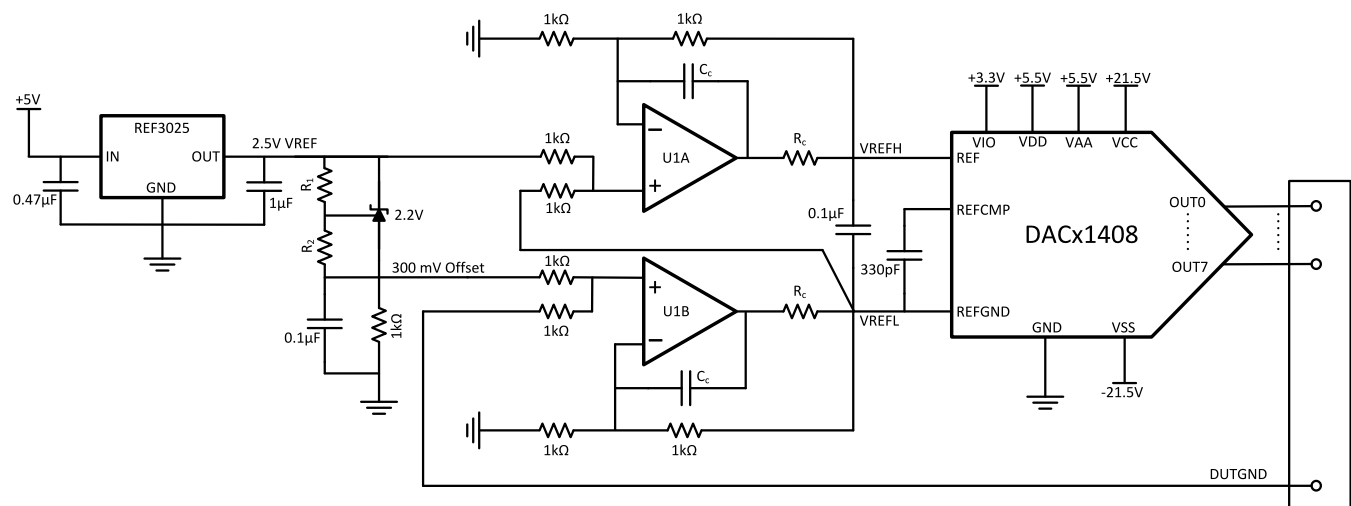


图 67. Schematic for Remote Ground Tracking

#### 10.2.1 Design Requirements

In ATE and Motor Control applications, typically the systems are designed modular wherein the control module is located spatially away from the Device Under Test (DUT) module. Such a scheme allows ground potentials across modules to vary due to the impedance of the interconnects. This ground potential variation, in turn introduces inaccuracies to the DAC output when measured with respect to the remote or DUT ground. 图 67 provides a method to compensate the variations in the remote ground. The ground variation in such applications is typically within  $\pm 300$  mV that includes DC and 50 Hz/60 Hz mains frequency components. While the best way to handle this variation is to put opamps in level shifter configuration at each output, a low cost and low footprint solution is always preferable. The following sections focus on the latter approach.

## Typical Application (接下页)

### 10.2.2 Detailed Design Procedure for Remote Ground Tracking

In order to make the DAC outputs follow the remote ground, the best approach is to level shift the reference input. 图 67 depicts a method wherein both the REF and REFGND inputs are level shifted with respect to DUTGND. However, as the DAC doesn't allow the REFGND to become negative compared to GND, an offset voltage of 300mV needs to be applied as shown. This method requires an external 2.5V reference and a way to generate a stable 300-mV reference. A dual opamp U1 is used to shift both REFGND and REF by (DUTGND + 300-mV offset). 表 24 provides the nodal analysis of the circuit. As evident, the DAC outputs track the DUTGND with an offset of 300mV. This offset can be easily compensated in software. Note that the absolute max values between REFGND and GND must be respected. When the absolute max values are reached, they should only be for a transient period and not for sustained amount of time.

**表 24. Nodal Analysis of the Circuit**

| DUTGND<br>(GND±0.3V) | REFGND PIN | REF PIN | VOUT-GND AT<br>0V CODE | VOUT-GND AT 5V<br>CODE | VOUT-DUTGND AT<br>0V CODE | VOUT-DUTGND<br>AT 5V CODE |
|----------------------|------------|---------|------------------------|------------------------|---------------------------|---------------------------|
| 0V                   | 0.3V       | 2.8V    | 0.3V                   | 5.3V                   | 0.3V                      | 5.3V                      |
| 0.3V                 | 0.6V       | 3.1V    | 0.6V                   | 5.6V                   | 0.3V                      | 5.3V                      |
| -0.3V                | 0V         | 2.5V    | 0V                     | 5V                     | 0.3V                      | 5.3V                      |

#### 10.2.2.1 Generating 300mV Offset

There is no off-the-shelf solution for generating a 300-mV offset, unfortunately. 图 67 depicts a method to generate it using discrete components. It uses LM4041 adjustable shunt regulator on high-side from the 2.5-V reference. It has a reference input pin that sets the voltage across this device. Given that  $V_{Ref}$  is 1.233 V, choosing  $R1 = 16\text{ k}\Omega$  and  $R2 = 12\text{ k}\Omega$  the voltage  $V_o$  can be calculated by superposition as 2.16 V. This will provide an offset of  $(2.5\text{ V} - 2.16\text{ V}) = 340\text{ mV}$  that will provide a safe margin from DAC ground.

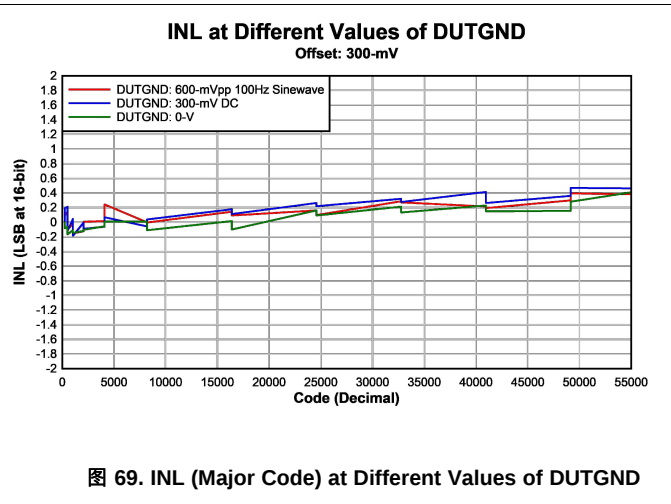
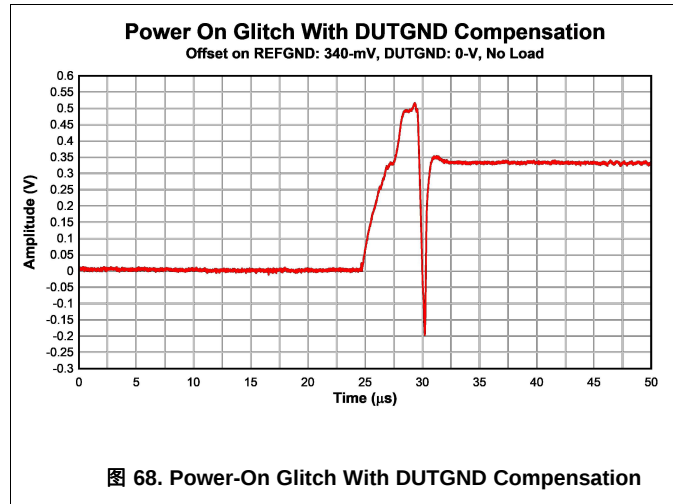
#### 10.2.2.2 Amplifier Selection

The amplifier needs to be bipolar in order to operate linearly near ground. A dual package is preferable for optimizing area. Considering these factors, TLV2442A seems to be the best option from cost and accuracy points of view. Other parts like OPA2277 can be used when higher accuracy is required.

#### 10.2.2.3 Passive Component Selection

In order to minimize additional offset and gain error the gain resistors around the opamps need to be matched. An 8-channel resistor network can be used for better matching.  $R_c$  and  $C_c$  values can be chosen as  $22\text{ }\Omega$  and  $1000\text{ pF}$ , respectively in order to compensate the pole caused by the large bypass capacitor at the opamp outputs.

### 10.2.3 Application Curves



## 11 Power Supply Recommendations

The DACx1408 requires 5 power supply inputs: VIO, VDD, VAA, VCC and VSS. VDD and VAA should be at same level. Assuming VIO and VDD/VAA to be different, there are 4 separate power supply sources required. It is recommended to provide a 0.1-μF ceramic capacitor close to each power supply pin. Please note that VCC and VSS have 2 pins each. In addition, a 4.7-μF or 10-μF bulk capacitor is recommended for each power supply. Tantalum or aluminum types can be chosen for the bulk capacitors. There is no sequencing requirement for the power supplies. As the DAC output range is configurable, the power supply headroom should be taken care of for achieving linearity at codes close to power supply rails. When sourcing or sinking current from or to the DAC output, the heat dissipation needs to be considered. For example, a typical application of MZM bias with 25-mA load current from or to 12 channels with 2.5-V power supply headroom can create a power dissipation across the DAC of  $(12 \times 2.5 \times 25 \text{ mA}) = 0.75 \text{ W}$ . The thermal design to dissipate this much of power may involve inclusion of heat sinks in order to avoid thermal shutdown of the device.

## 12 Layout

### 12.1 Layout Guidelines

The pin out of DACx1408 has been designed in such a way that the analog, digital and power pins are spatially separated from each other, which makes the PCB layout simple. An example layout is shown in 图 70. As evident, every power supply pin has a 0.1- $\mu$ F capacitor close to it. The layout of the analog and digital signals should be laid out away from each other or on different PCB layers. It is recommended to provide an unbroken reference plane (either ground or VIO) for the digital signals. The higher frequency signals such as SCLK and SDI should have appropriate impedance termination in order to address signal integrity.

### 12.2 Layout Example

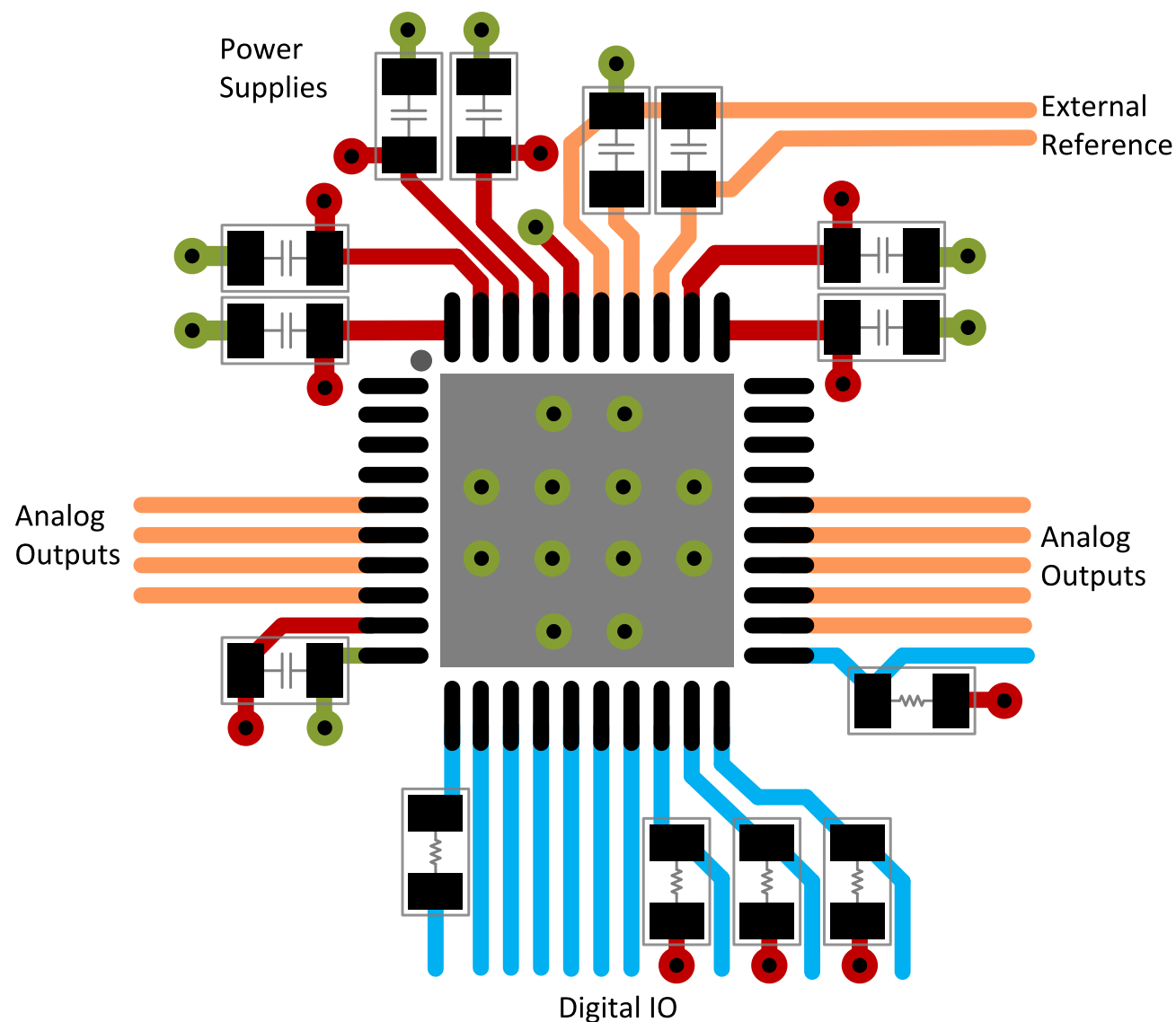


图 70. Example Layout

## 13 器件和文档支持

### 13.1 文档支持

### 13.2 相关链接

下表列出了快速访问链接。类别包括技术文档、支持与社区资源、工具和软件，以及申请样片或购买产品的快速链接。

表 25. 相关链接

| 器件       | 产品文件夹                 | 立即订购                  | 技术文档                  | 工具与软件                 | 支持和社区                 |
|----------|-----------------------|-----------------------|-----------------------|-----------------------|-----------------------|
| DAC81408 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| DAC71408 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |
| DAC61408 | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> | <a href="#">请单击此处</a> |

### 13.3 接收文档更新通知

要接收文档更新通知，请导航至 [TI.com.cn](#) 上的器件产品文件夹。单击右上角的通知我进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

### 13.4 社区资源

下列链接提供到 TI 社区资源的连接。链接的内容由各个分销商“按照原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《使用条款》。

**TI E2E™ 在线社区** *TI 的工程师对工程师 (E2E) 社区。* 此社区的创建目的在于促进工程师之间的协作。在 [e2e.ti.com](#) 中，您可以咨询问题、分享知识、拓展思路并与同行工程师一道帮助解决问题。

**设计支持** *TI 参考设计支持* 可帮助您快速查找有帮助的 E2E 论坛、设计支持工具以及技术支持的联系信息。

### 13.5 商标

E2E is a trademark of Texas Instruments.

### 13.6 静电放电警告



ESD 可能会损坏该集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理措施和安装程序，可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级，大至整个器件故障。精密的集成电路可能更容易受到损坏，这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

### 13.7 术语表

**SLYZ022** — *TI 术语表。*

这份术语表列出并解释术语、缩写和定义。

## 14 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是指定器件的最新可用数据。数据如有变更，恕不另行通知，且不会对此文档进行修订。如需获取此数据表的浏览器版本，请查阅左侧的导航栏。

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| DAC61408RHAR     | ACTIVE        | VQFN         | RHA                | 40   | 2500           | RoHS & Green    | NIPDAUAG                             | Level-3-260C-168 HR  | -40 to 125   | DAC61408                | <a href="#">Samples</a> |
| DAC61408RHAT     | ACTIVE        | VQFN         | RHA                | 40   | 250            | RoHS & Green    | NIPDAUAG                             | Level-3-260C-168 HR  | -40 to 125   | DAC61408                | <a href="#">Samples</a> |
| DAC71408RHAR     | ACTIVE        | VQFN         | RHA                | 40   | 2500           | RoHS & Green    | NIPDAUAG                             | Level-3-260C-168 HR  | -40 to 125   | DAC71408                | <a href="#">Samples</a> |
| DAC71408RHAT     | ACTIVE        | VQFN         | RHA                | 40   | 250            | RoHS & Green    | NIPDAUAG                             | Level-3-260C-168 HR  | -40 to 125   | DAC71408                | <a href="#">Samples</a> |
| DAC81408RHAR     | ACTIVE        | VQFN         | RHA                | 40   | 2500           | RoHS & Green    | NIPDAUAG                             | Level-3-260C-168 HR  | -40 to 125   | DAC81408                | <a href="#">Samples</a> |
| DAC81408RHAT     | ACTIVE        | VQFN         | RHA                | 40   | 250            | RoHS & Green    | NIPDAUAG                             | Level-3-260C-168 HR  | -40 to 125   | DAC81408                | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

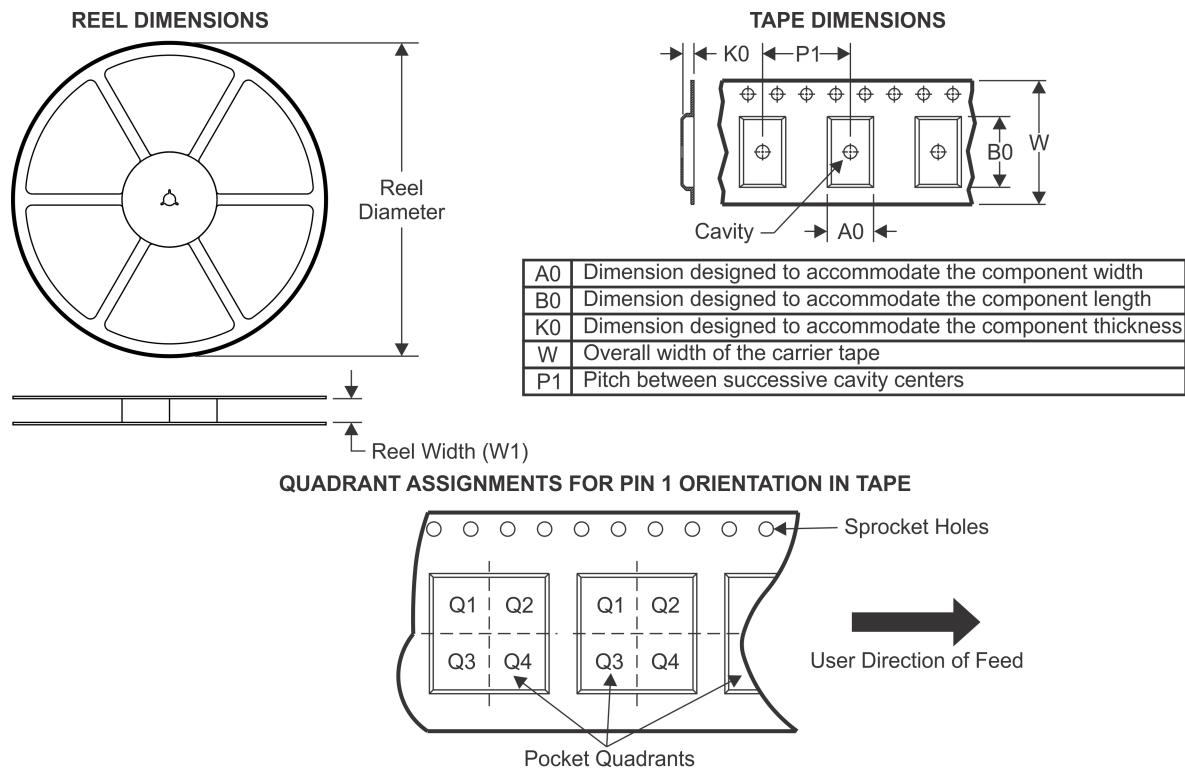
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

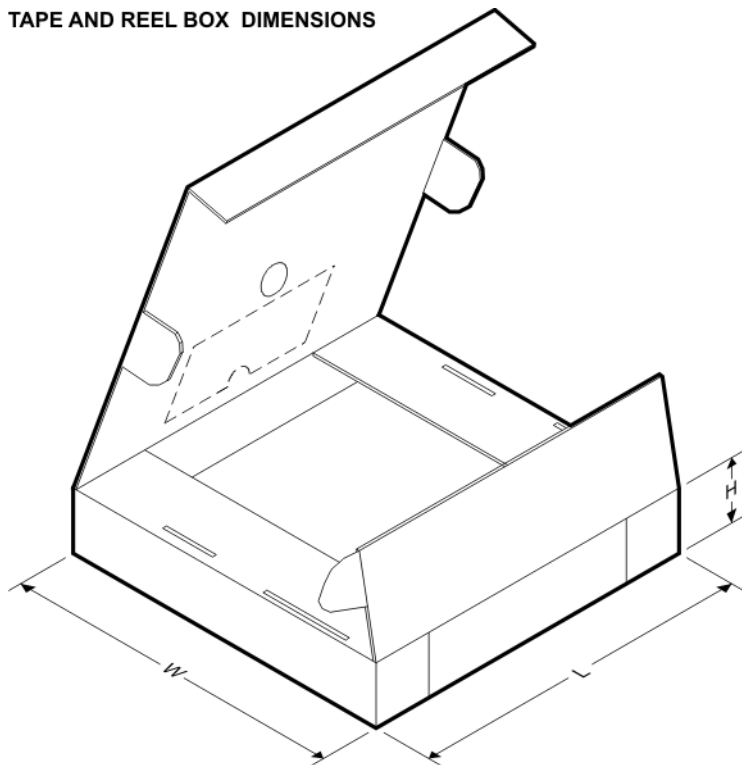
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| DAC61408RHAR | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q1            |
| DAC61408RHAT | VQFN         | RHA             | 40   | 250  | 180.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q1            |
| DAC71408RHAR | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q1            |
| DAC71408RHAT | VQFN         | RHA             | 40   | 250  | 180.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q1            |
| DAC81408RHAR | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q1            |
| DAC81408RHAT | VQFN         | RHA             | 40   | 250  | 180.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| DAC61408RHAR | VQFN         | RHA             | 40   | 2500 | 367.0       | 367.0      | 38.0        |
| DAC61408RHAT | VQFN         | RHA             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| DAC71408RHAR | VQFN         | RHA             | 40   | 2500 | 367.0       | 367.0      | 38.0        |
| DAC71408RHAT | VQFN         | RHA             | 40   | 250  | 213.0       | 191.0      | 35.0        |
| DAC81408RHAR | VQFN         | RHA             | 40   | 2500 | 367.0       | 367.0      | 38.0        |
| DAC81408RHAT | VQFN         | RHA             | 40   | 250  | 213.0       | 191.0      | 35.0        |

## GENERIC PACKAGE VIEW

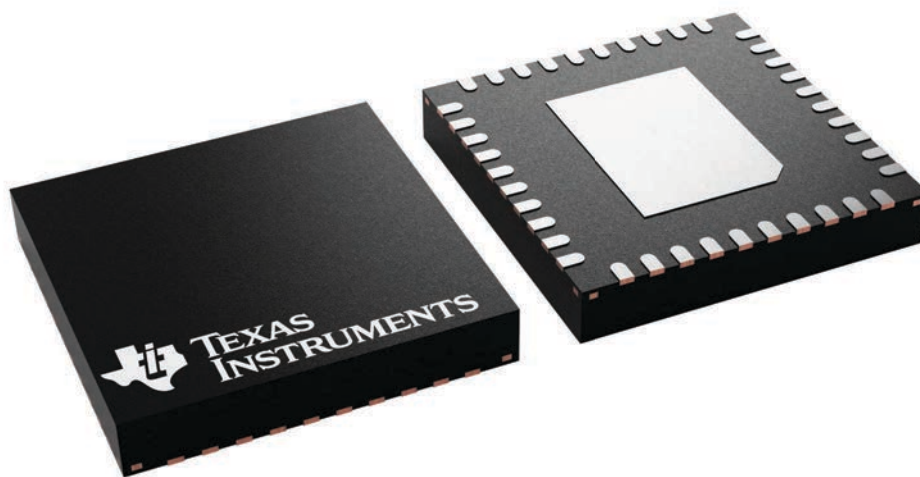
**RHA 40**

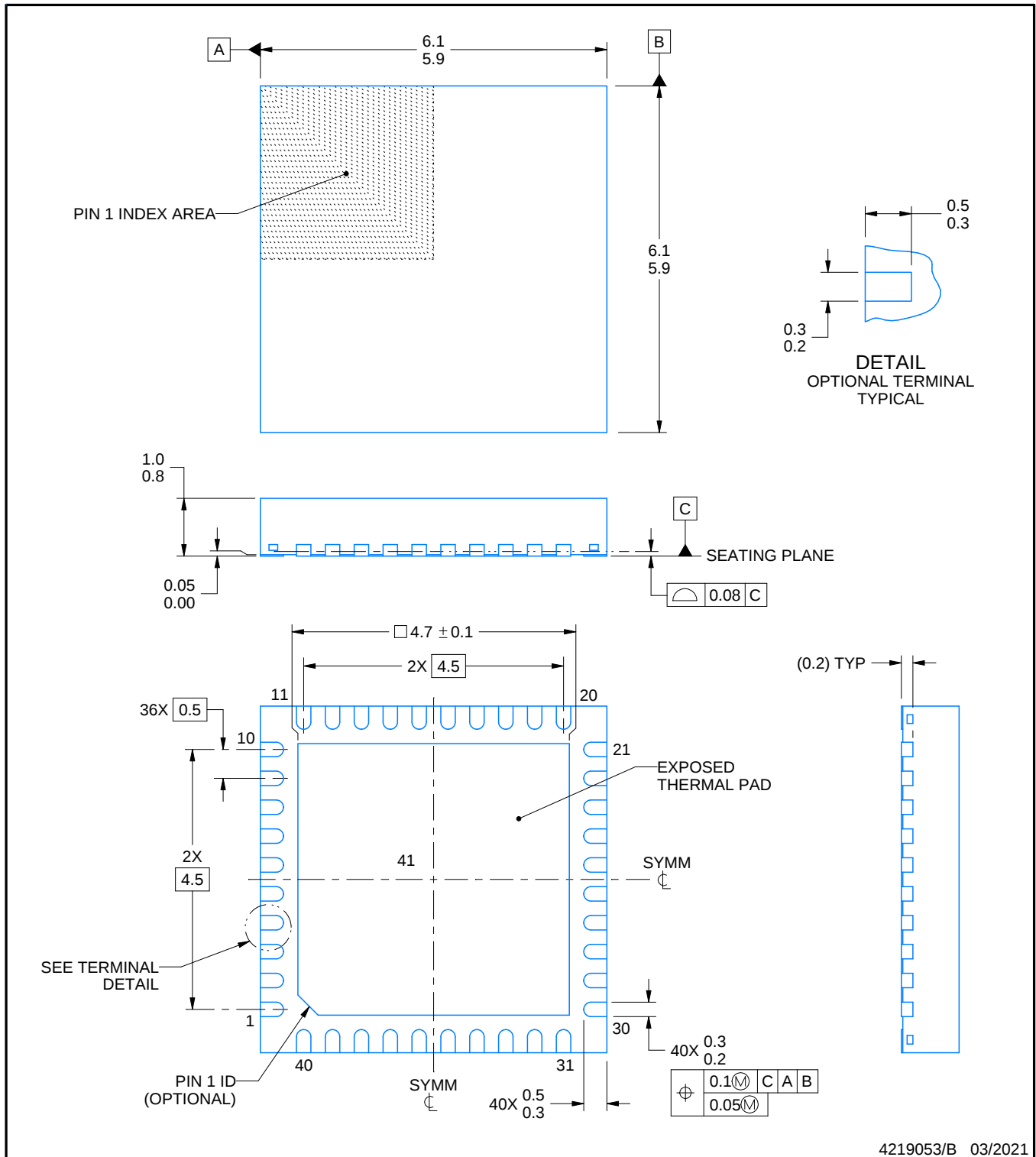
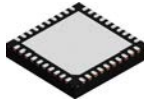
**VQFN - 1 mm max height**

6 x 6, 0.5 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.





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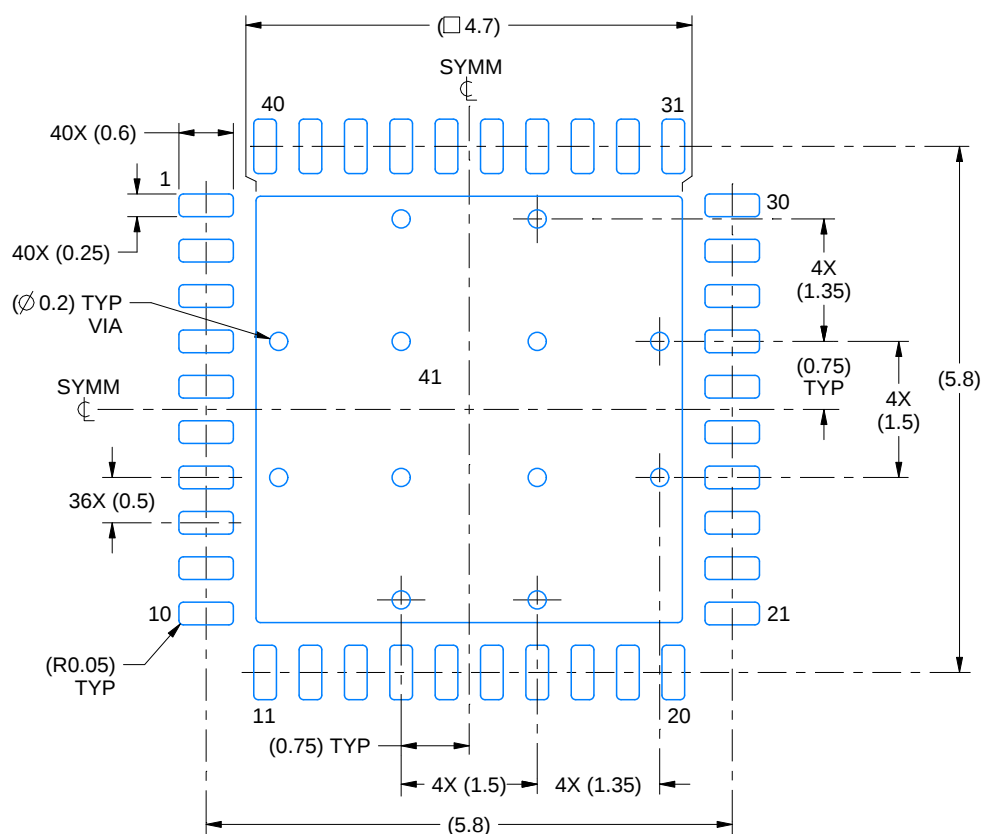
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

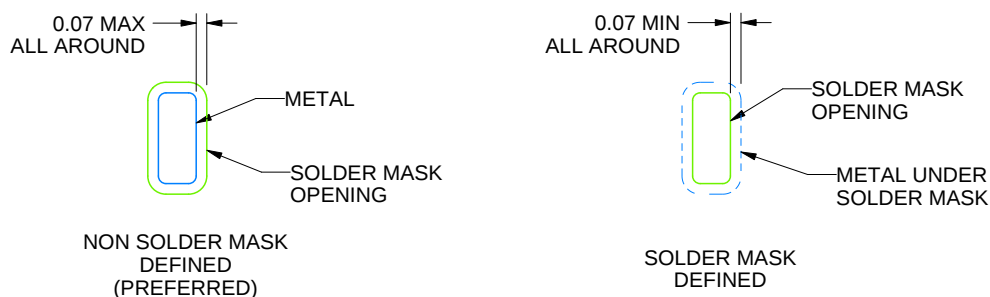
# RHA0040C

### VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:12X



## SOLDER MASK DETAILS

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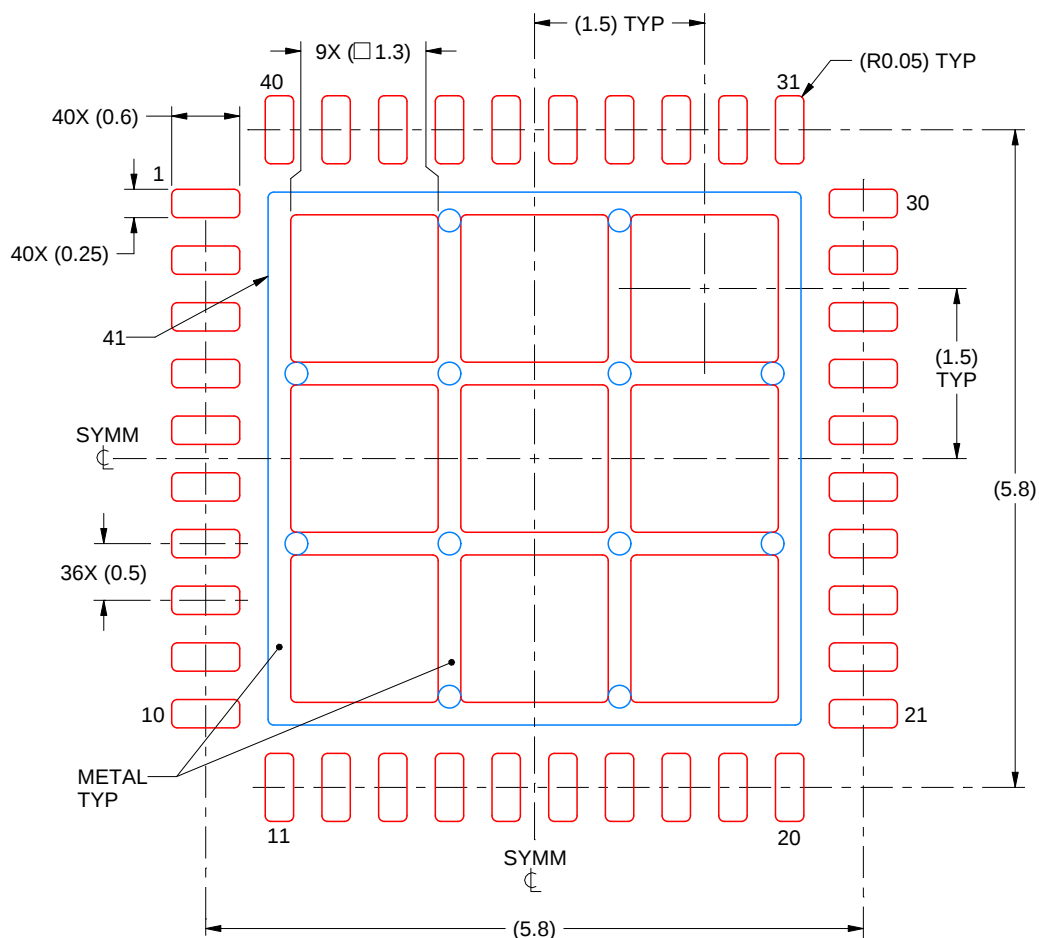
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/slua271](http://www.ti.com/lit/slua271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# RHA0040C

**VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



## SOLDER PASTE EXAMPLE BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 41:  
69% PRINTED SOLDER COVERAGE BY AREA  
SCALE:15X

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NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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